

FIG. 1A

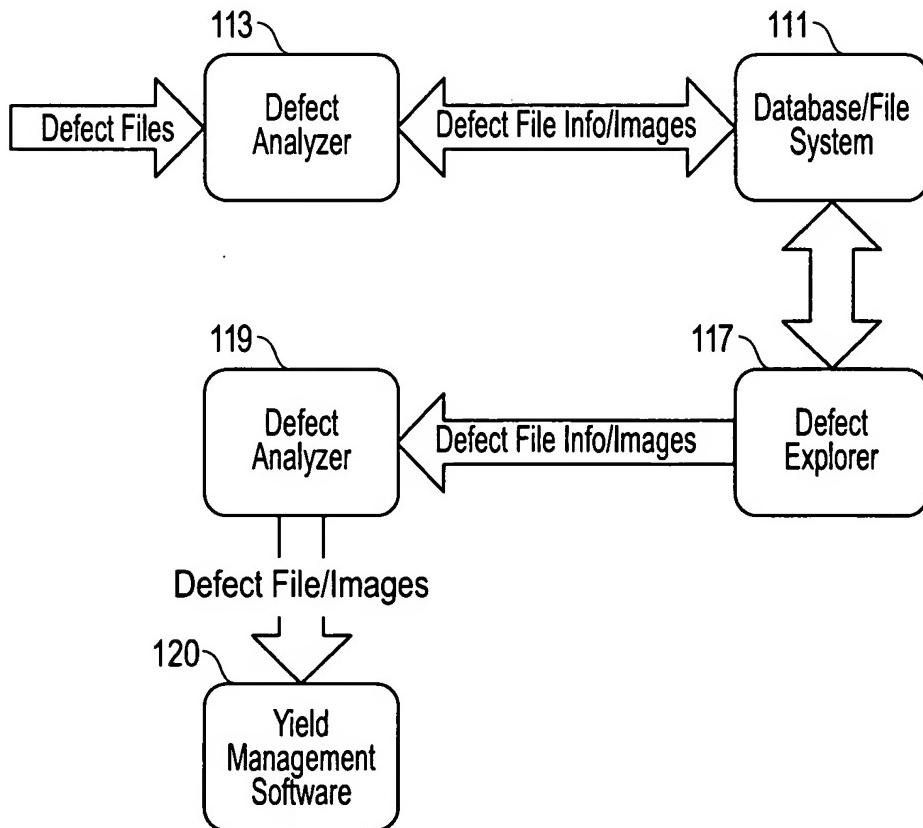


FIG. 1B

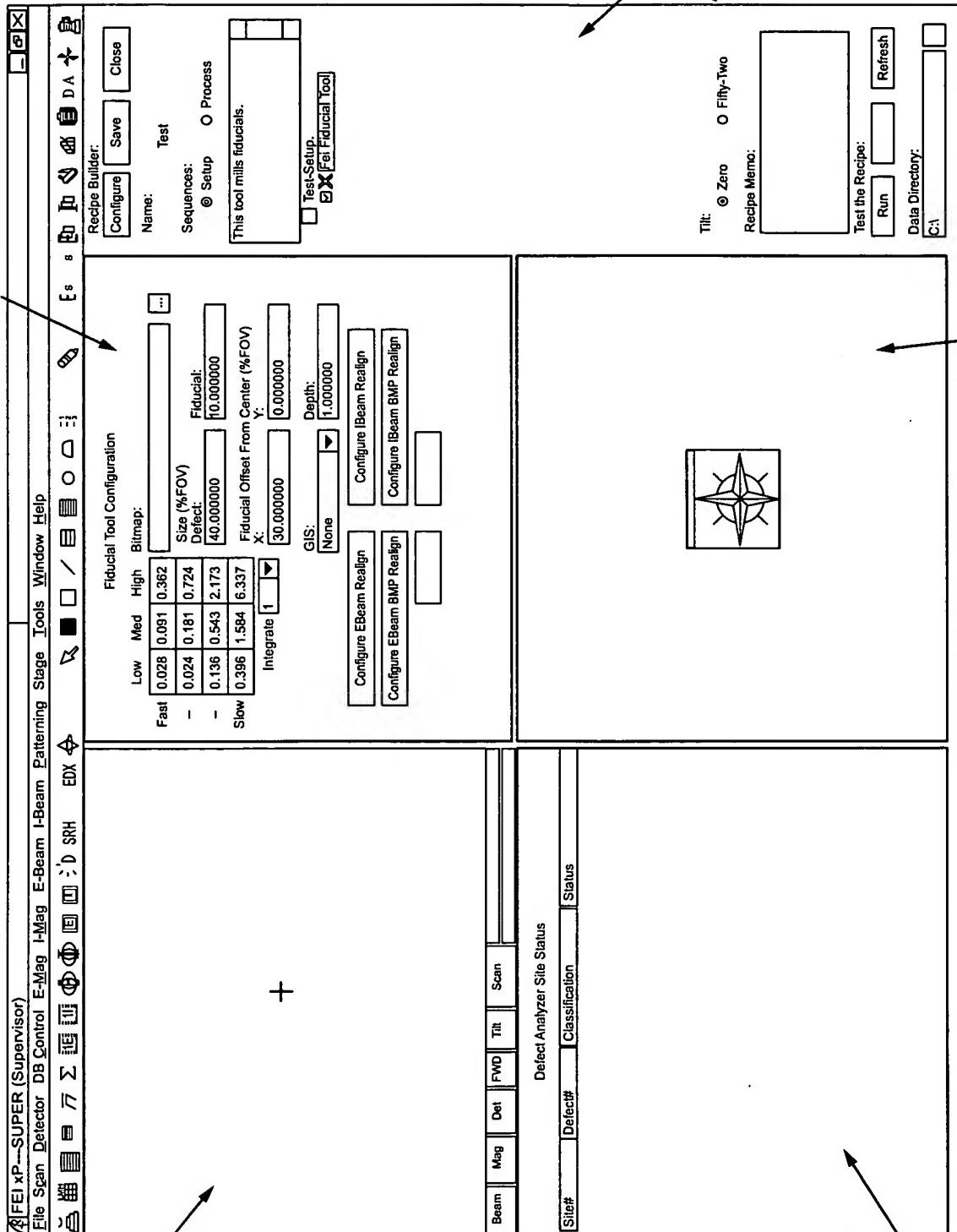
Tool Quadrant  
225Image  
Quadrant  
205Site Status  
Quadrant  
215Navigation  
Quadrant  
235

FIG. 2

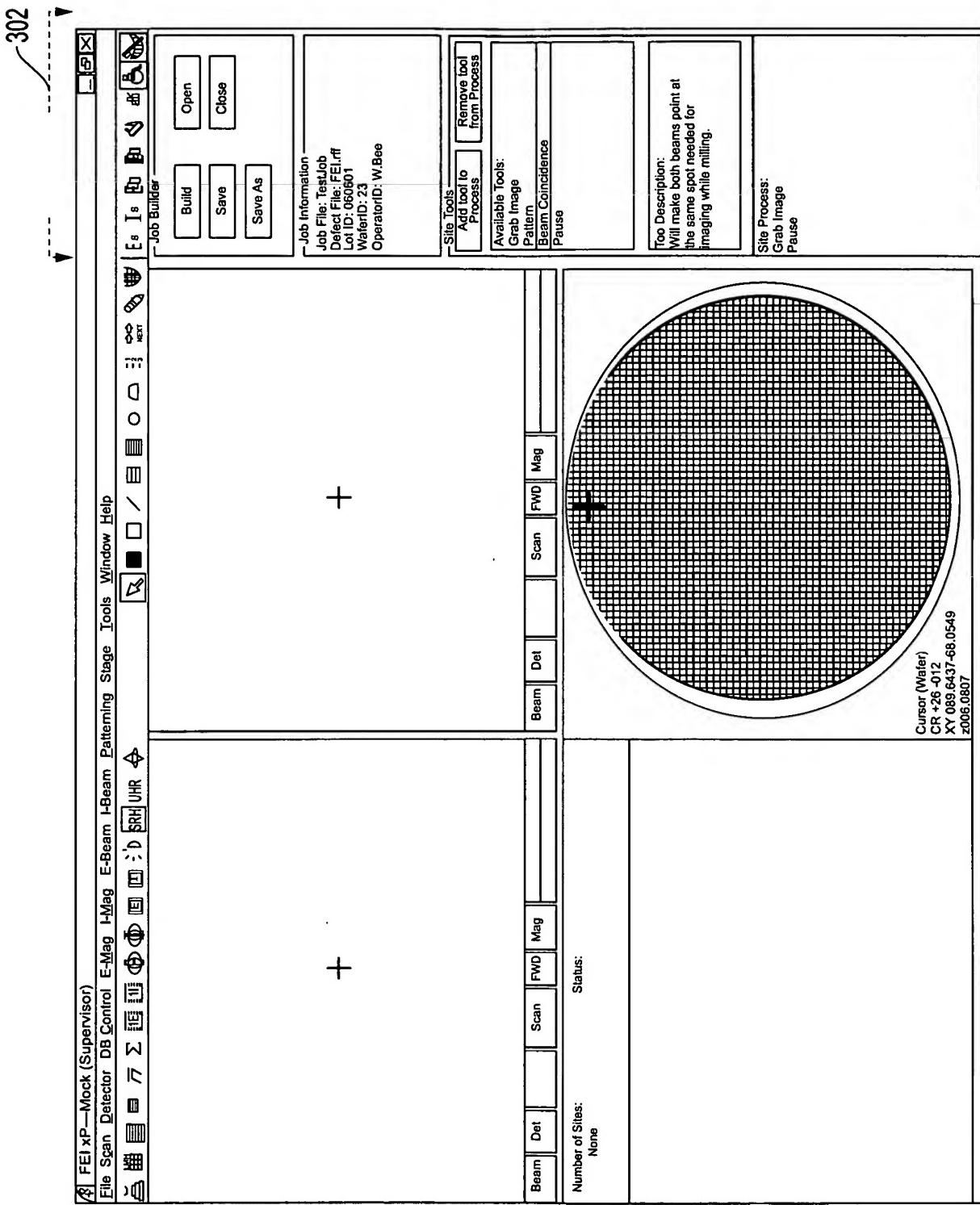


FIG. 3A

Item	Description
<b>Job Builder:</b>	
Build	Initiates building of new job
Save	Save the job information.
Save As	Functions conventionally
Open	Functions conventionally
Close	Functions conventionally
Job Information	Functions conventionally
<b>Site Tools:</b>	
Add Tool to Process	Inserts selected tool into process
Remove Tool from Process	removes selected tool from process
Available Tools	Displays tools available for processes
Tool Description	Brief description of tool
Site Process	Displays process (recipe) as it is being constructed by user

FIG. 3B

Available Tools:
Grab Image
Pattern
Beam Coincidence
Pause
Tool Description:
Will make both beams point at the same spot needed for imaging while milling
Site Process:
Grab Image
Pause

FIG. 3C

Job Wafer Data Input

Job Wafer Data Input

Operator ID:	<input type="text" value="W. Bee"/>	<input type="button" value="..."/>
Defect File:	<input type="text" value="fei.rff"/>	<input type="button" value="..."/>
Lot ID:	<input type="text" value="060265"/>	<input type="button" value="..."/>
Wafer ID:	<input type="text" value="01"/>	<input type="button" value="..."/>
Job File:	<input type="text" value="TestJob.dar"/>	<input type="button" value="..."/>
Product:	<input type="text" value="Train Align"/>	<input type="button" value="..."/>

Unload Wafer when Job Complete

FIG. 3D

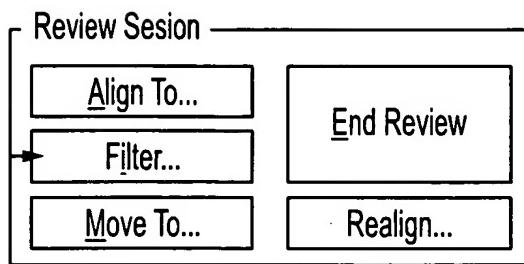


FIG. 3E

### Edit Active Site Filter

**Filter Name**

**Filter Criteria**

Classification <input checked="" type="checkbox"/>	1,2,3-4,7	<input type="button" value="New"/>	<input type="button" value="Open..."/>
Size x (µm) <input checked="" type="checkbox"/>	2-12	<input type="button" value="Save"/>	<input type="button" value="Save As..."/>
Size y (µm) <input checked="" type="checkbox"/>	1,2	<b>Random Subset</b>	
Die Column: <input type="checkbox"/>		<input type="checkbox"/> Enable Random Subset	
Die Row <input type="checkbox"/>		50	Percent <input type="button" value="▼"/>
SLI <input type="checkbox"/>		<b>Test Results</b>	
Visited <input checked="" type="checkbox"/>	Yes <input type="radio"/>	No <input type="radio"/>	<input type="button" value="Apply Now"/>
Modified <input checked="" type="checkbox"/>	Yes <input type="radio"/>	No <input type="radio"/>	Total Sites 595
Has Image <input type="checkbox"/>	Yes <input type="radio"/>	No <input type="radio"/>	Filtered Out 0
ADE Channel <input type="checkbox"/>	Light <input type="radio"/>	Dark <input type="radio"/>	Remaining 595
SP1 Channel <input checked="" type="checkbox"/> Composite		<input type="checkbox"/> Temporary Disable Filter	
Modified <input checked="" type="checkbox"/> Bright Field			
Modified <input checked="" type="checkbox"/> Dark Wide			
Modified <input checked="" type="checkbox"/> Dark Narrow			

FIG. 3F

Interface Items	Description
Filter Name	Identifies the filter.
Filter Criteria	These check boxes and list boxes select the filter criteria
New	Creates a new filter file.
Open	Opens an existing filter.
Save	Saves the edited filter definition. It is available only if allowed by configuration.
Save As	Saves the edited filter definition to a new file name. It is available only if allowed by configuration.
Random Subset	Specifies the maximum number of random sites passing the filter.
Test Results	Tests and reports the effect of site filter changes.
Temporarily Disable Filter	Temporarily disables the active site filter.
Graph	Displays a histogram of the defect sites.
Class List	Opens the Edit Class List dialog box.
Undo	Undoes the last change. You cannot undo changes already saved to file.
Undo All+	Undoes all changes made since dialog box opened. You cannot undo changes already saved to file.
Close	Close the dialog box. Applies the defined filter to the current review session but does not save the filter to file.

*FIG. 3G*

Criterion	Value Type	Description
Classification	Integer	Classification code assigned to the site
Size X ( $\mu\text{m}$ )	Real	X dimension of the site in microns
Size Y ( $\mu\text{m}$ )	Real	Y dimension of the site in microns
Die Column+n	Integer	Die column of the die containing the site
Die Row	Integer	Die row of the die containing the site
SLI	Integer	Scattered light intensity reported for the site
Visited	Yes/No	Site has or has not been visited during the review session
Modified	Yes/No	Site has or has not been classified or relocated during the review session
ADE Channel	Light/Dark	Site has or has not been visited during the review session
SP1 Channel	n/a	Site has selected attributes. This filter is active if the defect format is T7x00 and the defect file has more than one channel.
Has Image	Yes/No	Site has or does not have image data associated with it

FIG. 3H

Relational Operators	Meaning
=	Equal to
!=	Not equal to
<	Less than
<=	Less than or equal to
>	Greater than
>=	Greater than or equal to

FIG. 3I

**Random Subset**

Enable Random Subset

50	Percent	▼
Percent		
Maximum		

FIG. 3J

**Test Results**

Total Sites	68
Filtered Out	0
Remaining	68

FIG. 3K

Defect File	fei2.001
Wafer ID	@05
Lot ID	K54148350
Process ID	814FC
68 Total Sites, 68 Passing Filter	

FIG. 3L

Temporarily Disable Filter

FIG. 3M

Defect #	Size X	Size Y	Classification Recipe Name	Die Row

FIG. 3N

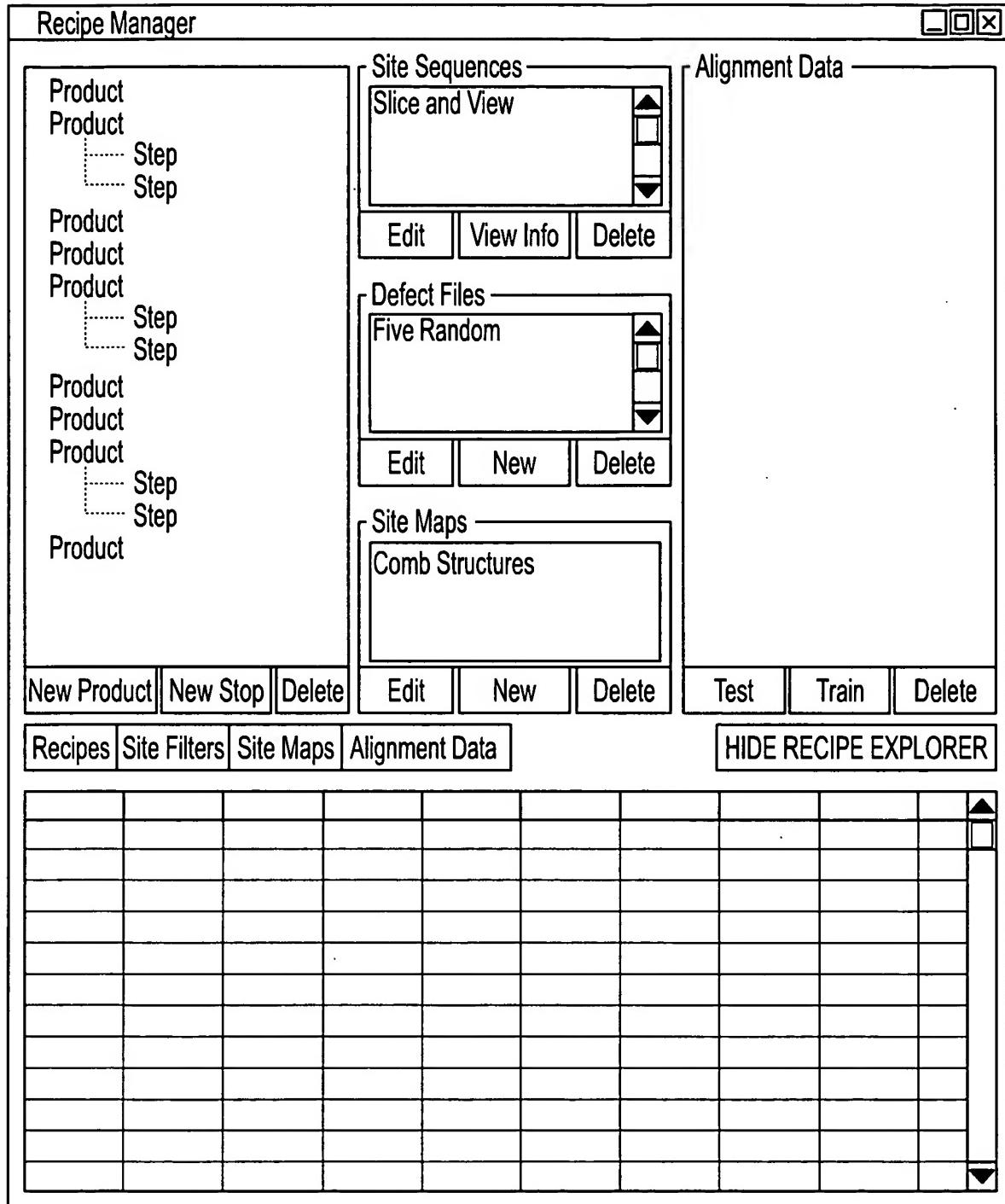


FIG. 30

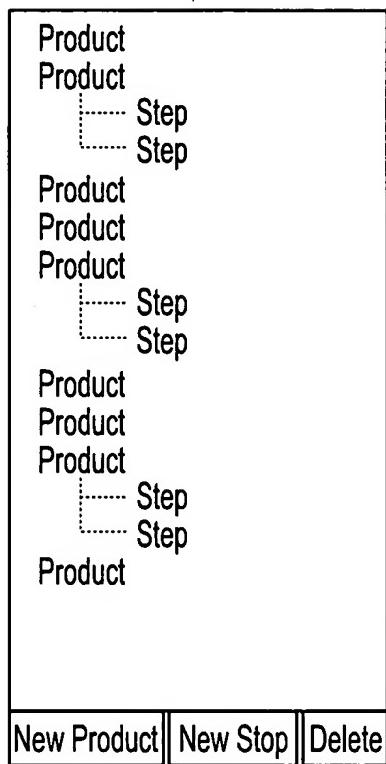


FIG. 3P

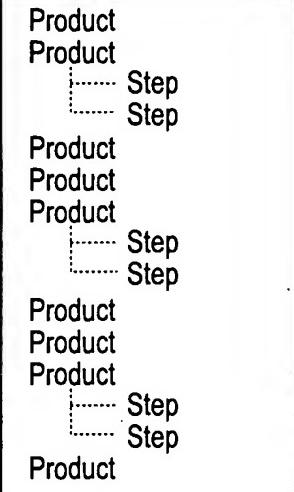
Control	Descriptions	Behavior
 <pre> graph TD     Product1[Product] --- Step1[Step]     Product1 --- Step2[Step]     Product2[Product] --- Step3[Step]     Product2 --- Step4[Step]     Product3[Product] --- Step5[Step]     Product3 --- Step6[Step]     Product4[Product]   </pre>	<p>Product/Step Tree: This is the interface through which specific Steps are created, edited, and deleted.</p>	<p>Sorting: Alphabetized by Product, then by Step.</p> <p>Node Behavior: Expandable and Collapsible through a standard interface. Persist Expansions for the life of the dialogue.</p> <p>Scroll Bars: Scrolling should be allowed.</p>
	<p>New Product Button: This is used to add a New Product to the Database.</p>	<p>Click: This should launch a "New Product Wizard" which is described below.</p>
	<p>New Step Button: This is used to add a New Step to whichever product is selected in the Product/Step Tree View (above).</p>	<p>Enable/Disable: Enable if a Product has been selected. Disabled otherwise.</p> <p>Click: This should launch the "New Step Wizard" which is described below.</p>
	<p>Delete Button: This is used to remove products or steps from the database</p>	<p>Click: This should launch a standard two-button dialogue with the message. "Permanently Delete [Product/Step] Information?". Then buttons are "Cancel" and "OK".</p>

FIG. 3Q

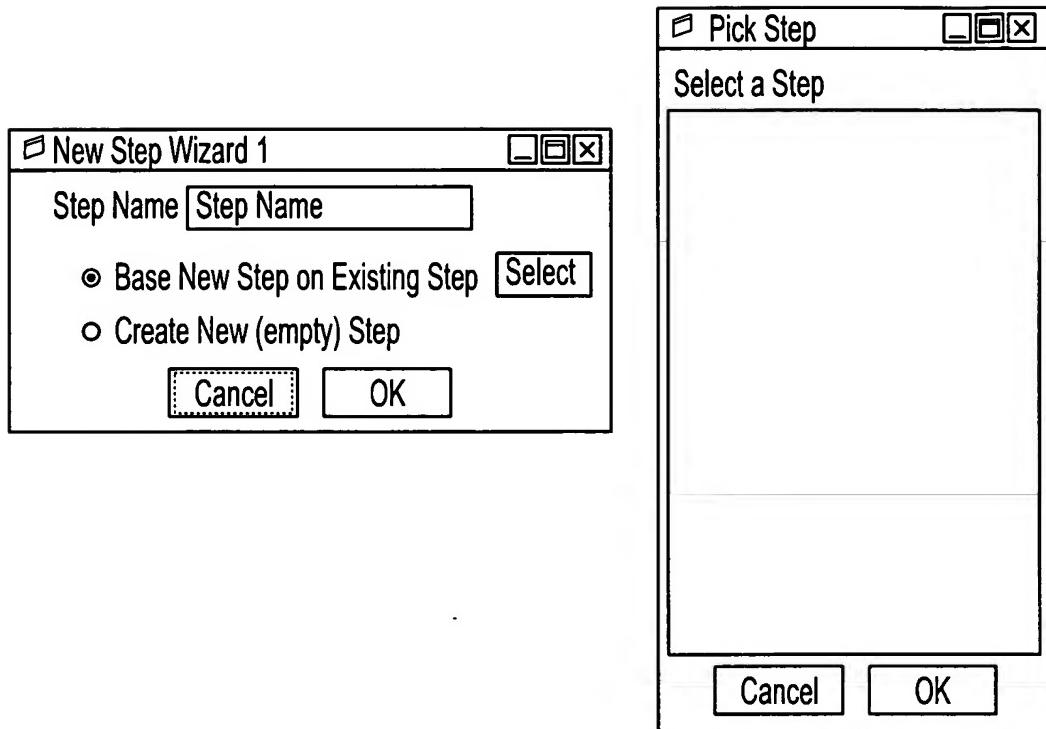


FIG. 3R

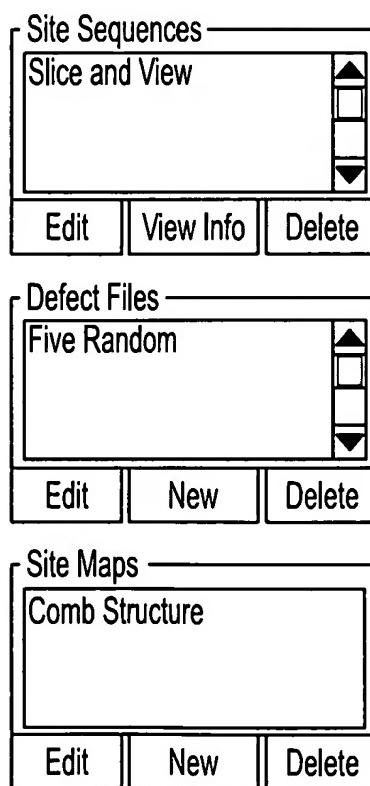


FIG. 3S

Control	Descriptions	Behavior
	Site Sequence List Tree View: This displays a list of Site Sequences which can be expanded to show the names of the tools.	Scrolling: Should be scrollable. Node Behavior: Expanded nodes should stay expanded. Alphabetized. Click: This should highlight the site sequence. Default selection: The first site sequence in the list should be highlighted by default. Double-Click: This should expand the node to display the list of tools within the site sequence. Mouse Over: This should display the Site Sequence Name followed by the text description of the site sequence (if any).
	Edit Button: This loads the site sequence into the Recipe Builder page.	(Optionally) the page display should be switched to the Recipe Builder Click: Load the selected site sequence into the recipe builder page
	View Info Button: THIS BUTTON HAS BEEN REMOVED.	NOT APPLICABLE. (the tree view functionality eliminates the previously envisioned function of this button).
	Delete Button: This button removes the site sequence from the database.	Click: This removes the site sequence from the database as far as the user is concerned. The actual implementation should include an "Is Deleted" flag to indicate that the site sequence should not be displayed. This will prevent previously configured process from being invalidated.
	Site Filter Text Box: This shows a list of all Site Filters available for the selected Product/Step in the Product/Step Tree View control (above).	Alphabetize. Click: Highlight the site filter. Default Selection: The first of the list should be highlighted by default..
	Edit Button: This is used to edit the highlighted site filter.	Click: Launch the site filter dialog for the highlighted site filter.

FIG. 3T

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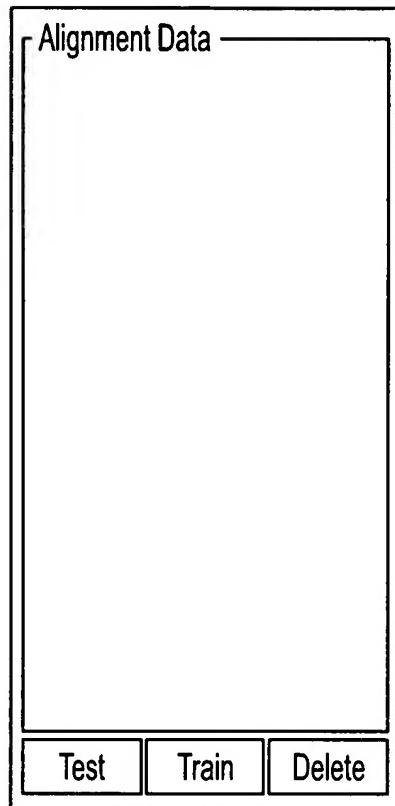
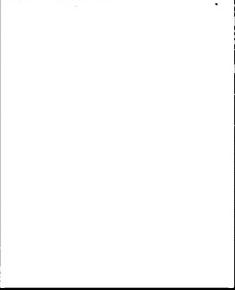


FIG. 3U

Recipes	Site Filters	Site Maps	Alignment Data	HIDE RECIPE EXPLORER				

FIG. 3W

Control	Descriptions	Behavior
	Alignment Data Tree View. This is a tree view showing the Alignment data in the following order.	<p>Node coloring: The nodes should be colored red if they or a child is untrained.</p> <p>Data Structure: A preliminary data structure for this tree is shown and described in the following section.</p>
	Test Button. If appropriate, this should test the selected alignment on the wafer loaded into the system.	<p>Enable/Disable: This is dependent on the highlight node of the Alignment Data Tree View. For certain alignments test functionality will not be appropriate and should not, therefore, be applied.</p> <p>Click: Run the alignment for the highlighted node and all child nodes in the Alignment Data Tree View.</p>
	Train Button. If appropriate, this should initiate the portion of the Alignment Training Wizard for the selected node.	<p>Enable/Disable: For some nodes this control may not make sense or may require functionality not provided by the software. In these situations the control should be either disabled or handled through a clear, concise error message. For example, training the zero degree alignments for a wafer loaded at 52 degrees might prompt the user to tilt to zero degrees and try the alignment again.</p> <p>Click: Run the portion(s) of the alignment training wizard for the highlighted node and child nodes. Note that there may be unanticipated exceptions that need to be dealt with (such as no wafer is loaded) that will require increased robustness in handling of errors and exceptions. These will be ferreted out at a later time.</p>
	Delete Button: This permanently deletes alignment data from the database.	Click: This should launch a standard two button dialogue with the message "This will

Control	Descriptions	Behavior
HIDE RECIPE EXPLORER		
Recipes	<p>Recipe Tab. This should have the following fields.</p> <ul style="list-style-type: none"> <li><input type="radio"/> Product</li> <li><input type="radio"/> Step</li> <li><input type="radio"/> Recipe Name</li> <li><input type="radio"/> Creation Date</li> </ul>	
Site Filters	<p>Site Filter Tab. This should have the fields listed below. As an added feature, there could be a "view filter button" to allow a quick look at the data through a new window</p> <ul style="list-style-type: none"> <li><input type="radio"/> Product</li> <li><input type="radio"/> Step</li> <li><input type="radio"/> Recipe Name</li> <li><input type="radio"/> Creation Date</li> </ul>	
Site Maps	<p>Site Map Tab. This should have the fields listed below. As an added feature, there could be a "view filter button" to allow a quick look at the data in a new window (similar to above).</p> <ul style="list-style-type: none"> <li><input type="radio"/> Product</li> <li><input type="radio"/> Step</li> <li><input type="radio"/> Recipe Name</li> <li><input type="radio"/> Creation Date</li> </ul>	
Alignment Data	<p>Site Map Tab. This is a complex control, but the should have the fields listed below. Alignment Node should be path which indicates where the alignment data exists on a tree structure identical to that described above.</p> <ul style="list-style-type: none"> <li><input type="radio"/> Product</li> </ul>	

◊ Alignment Name #1

- Wafer Alignment
  - Product Offset
  - Zero Degrees
    - Alignment Dies
    - Top-Down Electron Beam Image
    - Ion Beam Image
  - Fifty-Two Degrees
    - Alignment Dies
    - Ion Beam Image
    - Electron Beam Image
- System Calibrations
  - Height Probe Offset
    - Zero Degrees
    - Fifty-Two Degrees

◊ Alignment Name #2

*FIG. 3Y*

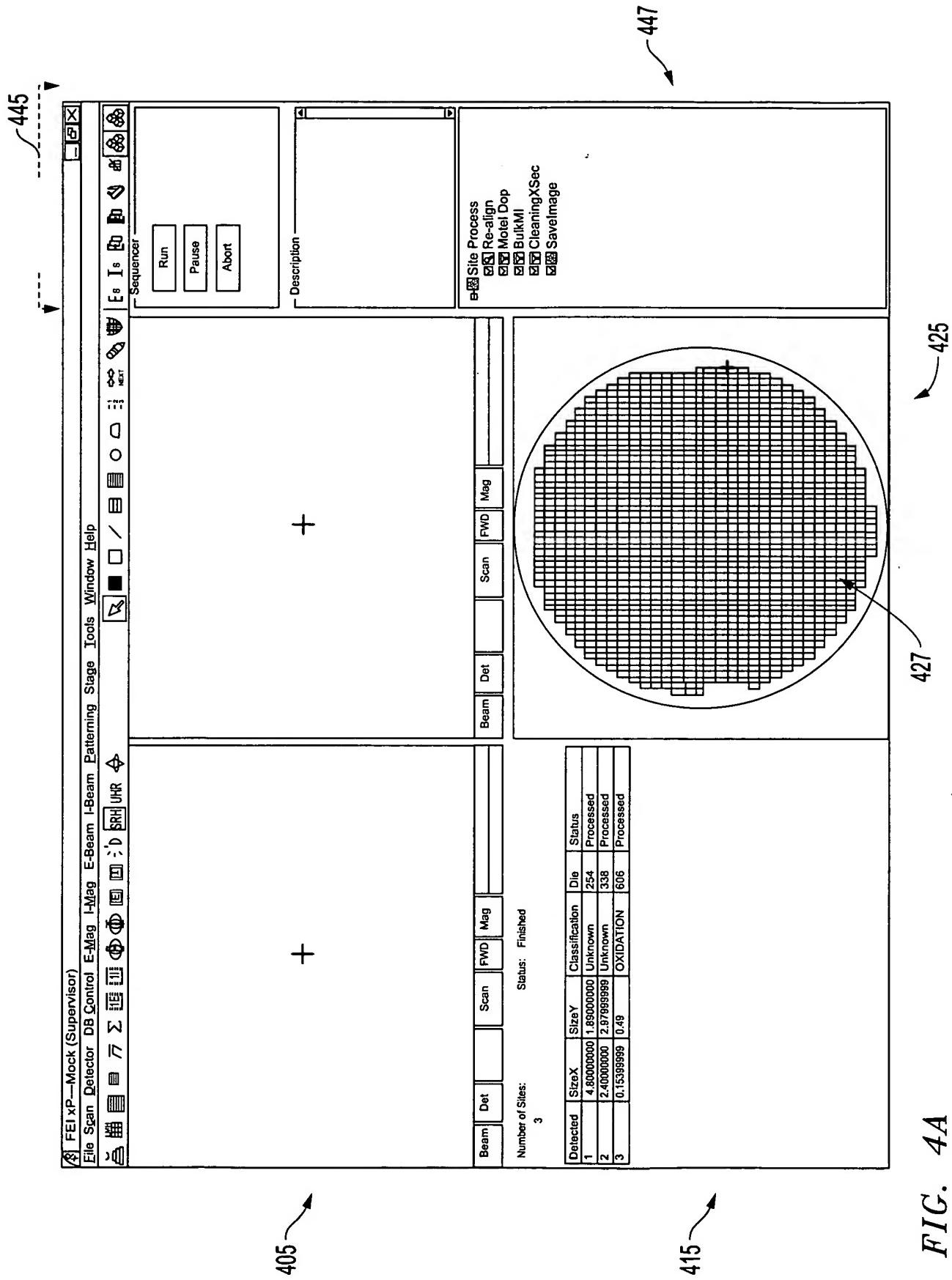


FIG. 4A

Item	Description
Run	Loads the wafer and runs the selected job.
Pause	Pause job execution
Abort	Terminate job execution
Description	Comment text describing job if included in job
Site Process	Displays job process tools

*FIG. 4B*

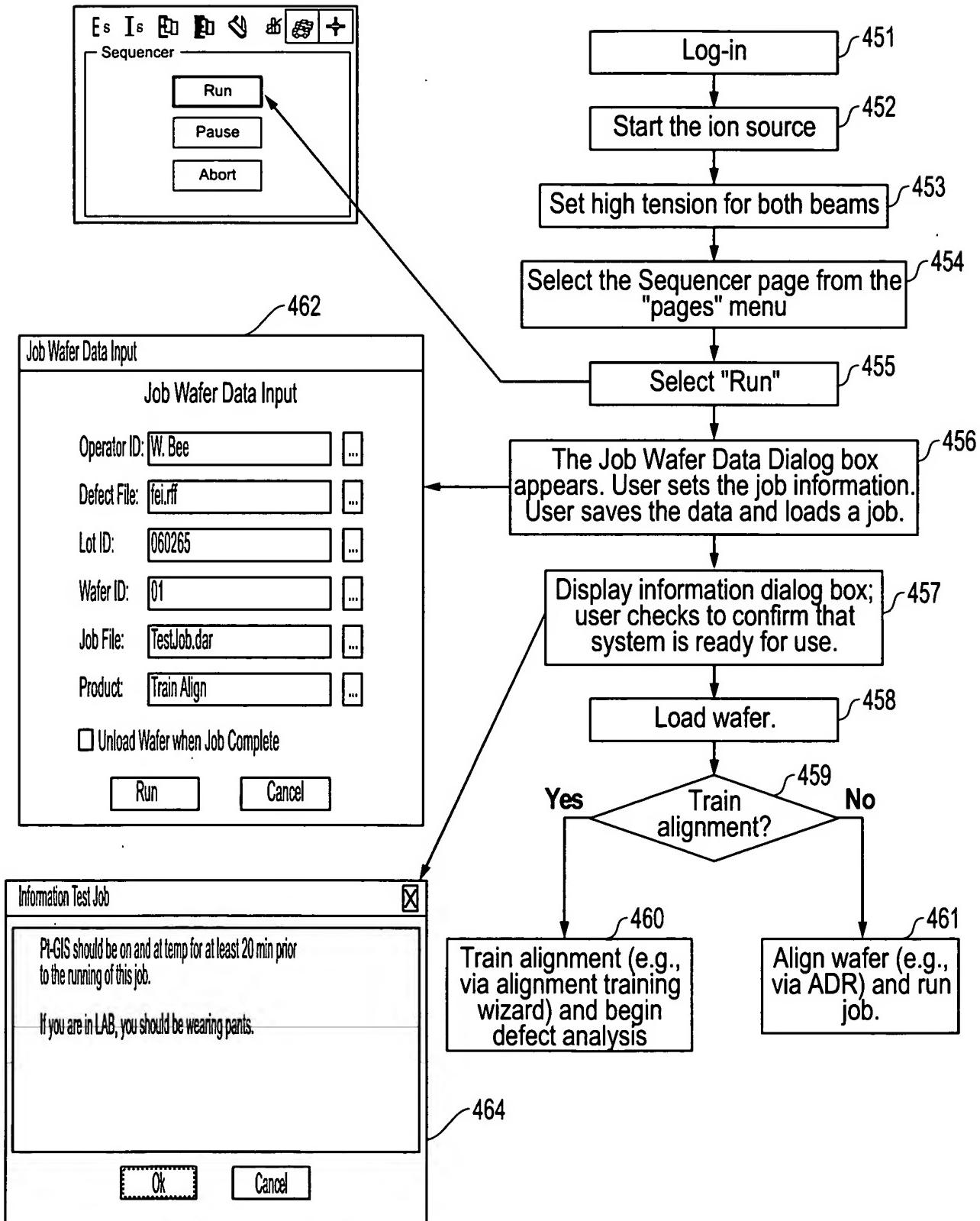


FIG. 4C

Job Wafer Data Input	
Job Wafer Data Input	
Operator ID:	[W. Bee]
Defect File:	[fei.rff]
Lot ID:	[060265]
Wafer ID:	[01]
Job File:	[TestJob.dar]
Product:	[Train Align]
<input type="checkbox"/> Unload Wafer when Job Complete	
<input type="button" value="Run"/>	<input type="button" value="Cancel"/>

FIG. 4D

Interface Items	Description
Operator ID	Required field where the user enters name.
Defect File	Defect file for the job. User opens an existing defect file. Clicking the select button opens the Select Defect dialog box.
Lot ID	Maximum of 15 characters. Value is read in from defect file or job file, selected from dialog box, or entered by the operator.
Wafer ID	Maximum of 5 characters. Value is read in from defect file or job file, selected from dialog box, or entered by the operator.
Job File	Selects a recipe or job file. The recipe contains no wafer information. the job file contains wafer information. They have different extensions, daj and .dar.
Product	Identifies the alignment wizard for the wafer. If TRAIN ALIGN is selected, when the user clicks RUN, the Alignment Training wizard starts.
Cass A/B	Shows the slots that are occupied.
Inventory	Inventories the cassettes.
FlexiLock	Shows if wafer is in the cassette.
Unload wafer when job complete	Provides automated wafer unloading when a job is complete.
RUN	Dialog box closes and the Information dialog box displays. When user clicks OK in information dialog box the sequencer runs the job. This button is not active until information for at least one wafer is entered.
Cancel	Dialog box closes without saving the values. In job builder, the dialog box closes and the Add Tool interface displays. In sequencer, a warming box displays so that the user does not unintentional lose information. Then, the Sequencer page becomes active again.
Select button	Open dialog where predefined files, wafer, etc., can be selected.

FIG. 4E

Job Wafer Data Input	
Job Wafer Data Input	
Operator ID:	W. Bee
Defect File:	fei.rff
Lot ID:	060265
Wafer ID:	01
Job File:	TestJob.dar
Product:	Train Align
<input type="button" value="Run"/> <input type="button" value="Cancel"/>	
Class A	Class B
1	1
2	2
3	3
4	4
5	5
6	6
7	7
8	8
9	9
10	10
11	11
12	12
13	13
14	14
15	15
16	16
17	17
18	18
19	19
20	20
21	21
22	22
23	23
24	24
25	25

FIG. 4F

Job Wafer Data Input	
Operator ID:	W. Bee
Defect File:	fei.rff
Lot ID:	060265
Wafer ID:	01
Job File:	TestJob.dar
Product:	Train Align
<input type="button" value="Run"/> <input type="button" value="Cancel"/>	
Class A	
1	2
3	4
5	6
7	8
9	10
11	12
13	14
15	16
17	18
19	20
21	22
23	24
25	
Class B	
1	2
3	4
5	6
7	8
9	10
11	12
13	14
15	16
17	18
19	20
21	22
23	24
25	
Inventory	
FlexiLock	
20	

FIG. 4G

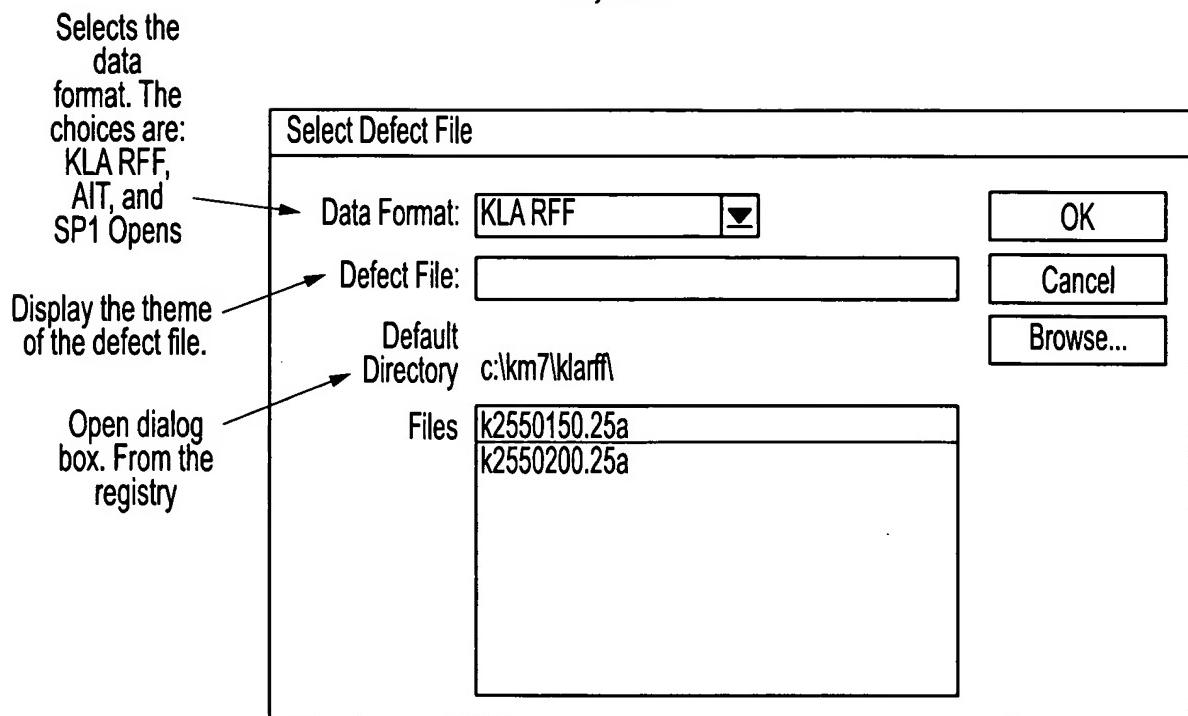


FIG. 4H

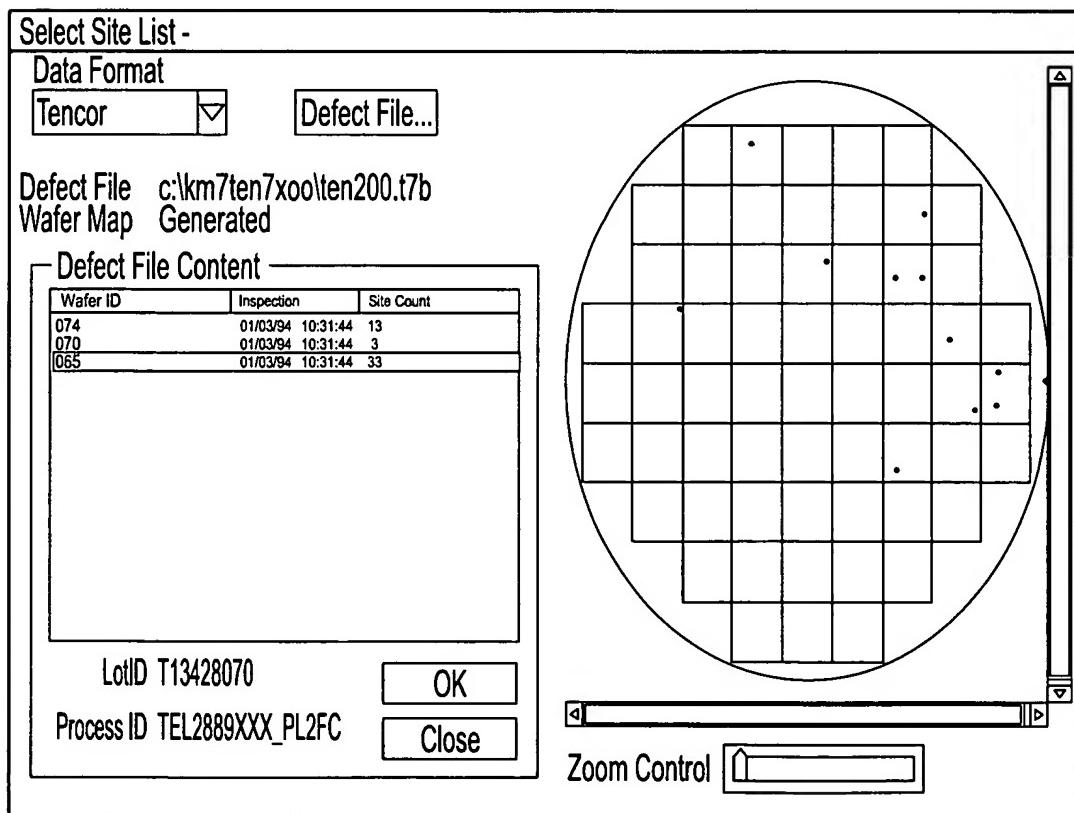


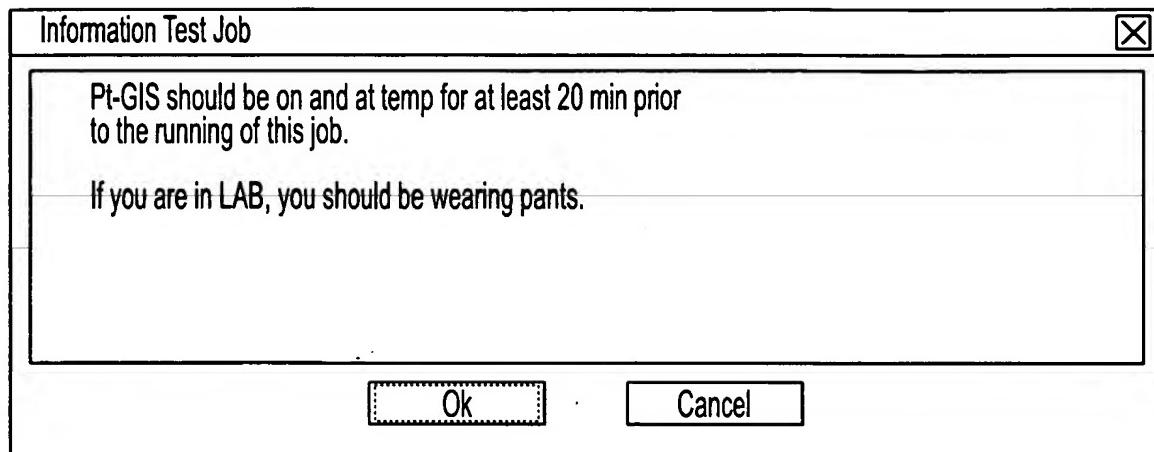
FIG. 4I

Defect File Contents		
Wafer ID	Inspection	Site Count

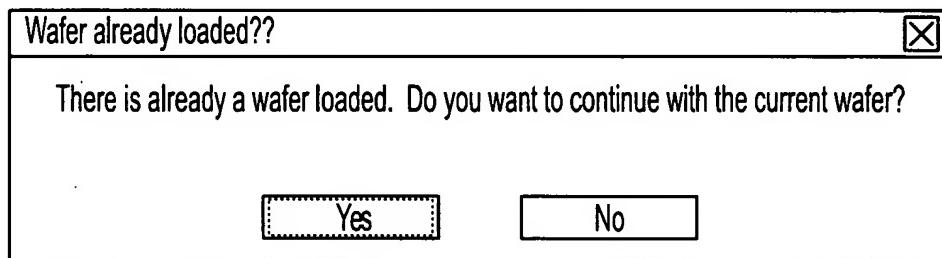
*FIG. 4J*

Column Header	Description
Wafer ID	The wafer ID as listed in the defect file.
Inspection	The date and time site list was created during inspection.
Wafer ID	The wafer ID as listed in the defect file.

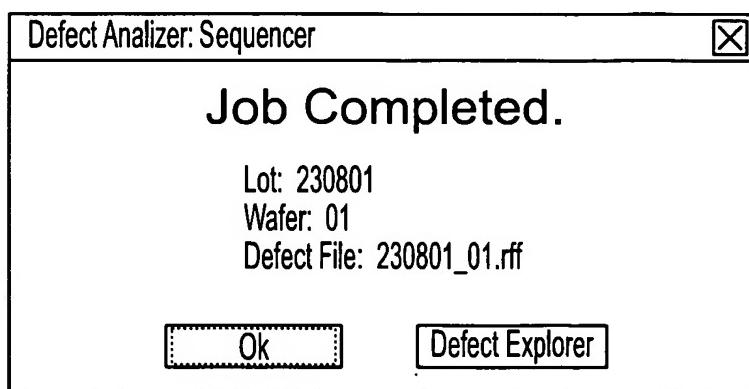
*FIG. 4K*



*FIG. 4L*



*FIG. 4M*



*FIG. 4N*

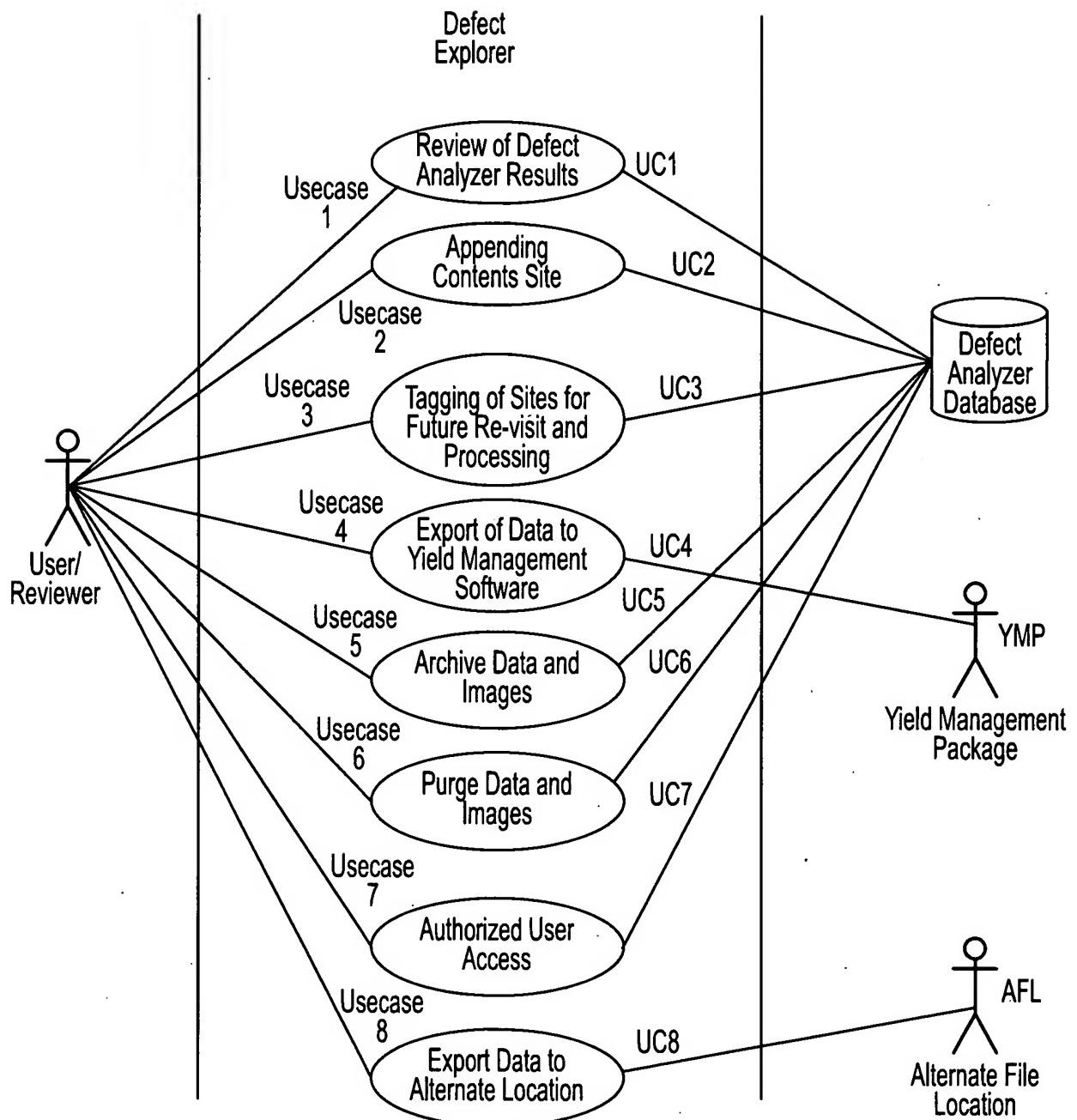


FIG. 5

FEI Defect Explore

Search Criteria:

Select

Lot ID      Wafer ID

Job Start Date      Job End Date      Search

Quick Search

My Last Day Jobs      My Last Week Jobs  
All Last Day Jobs      All Last Week Jobs

Job Details

<input checked="" type="checkbox"/> Job name		
<input checked="" type="checkbox"/> Job name		
<input checked="" type="checkbox"/> Job name		
<input checked="" type="checkbox"/> Job name		
<input checked="" type="checkbox"/> Job name		
<input checked="" type="checkbox"/> Job name		
<input checked="" type="checkbox"/> Job name		

Delete Job      Export      Next>      Cancel

FIG. 6A

FEI Defect Explore

Wafer details — Wafer Map

- Wafer 1
- Wafer 6

Show Wafer History

Wafer Map

Site details of Wafer xxxx

<input checked="" type="checkbox"/>			

Image

Select  None  Delete  Export

Thumb Nail Images of Site xxxx


Site Comments

Properties of Image x

ReClassify [Back](#) [Next>](#)

FIG. 6B

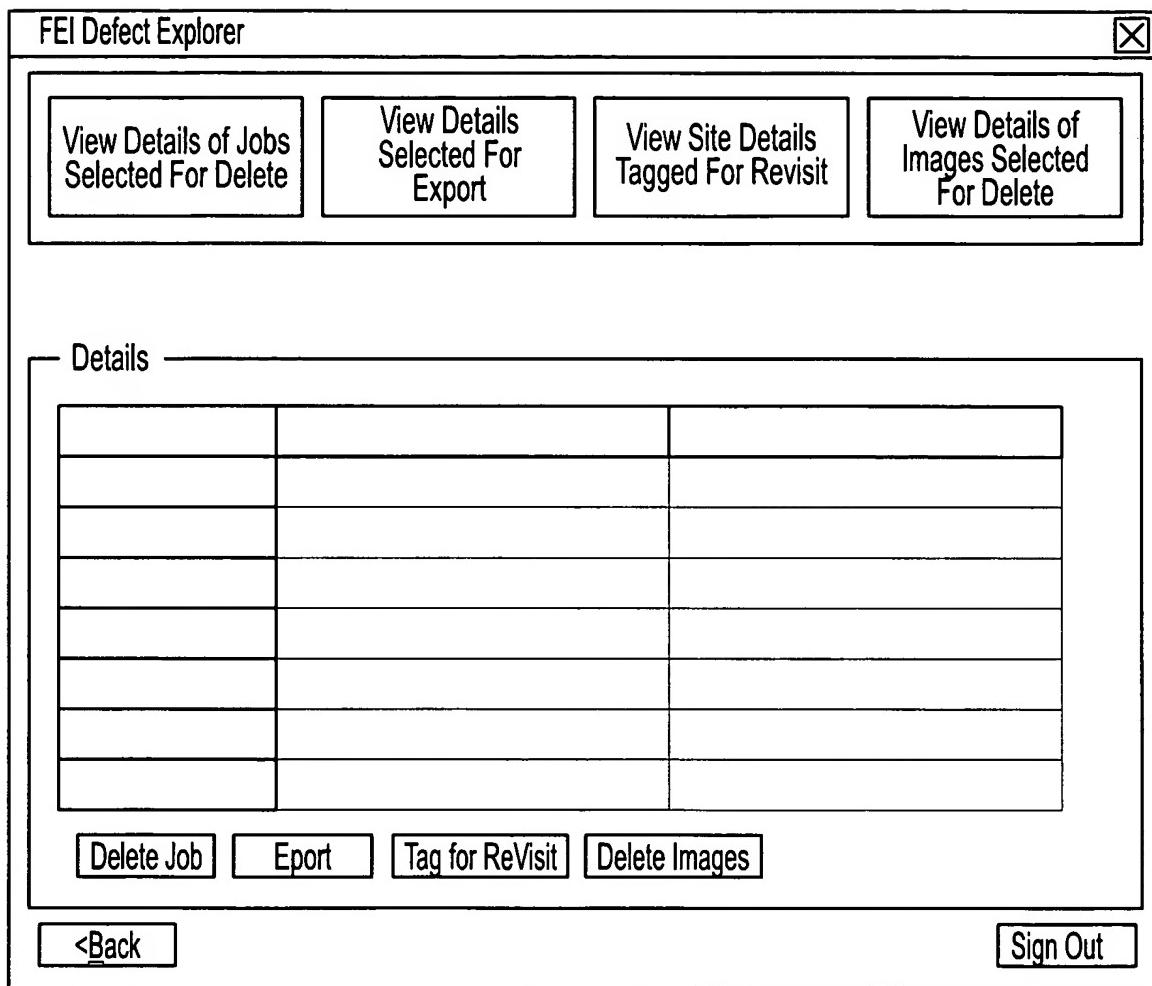


FIG. 6C

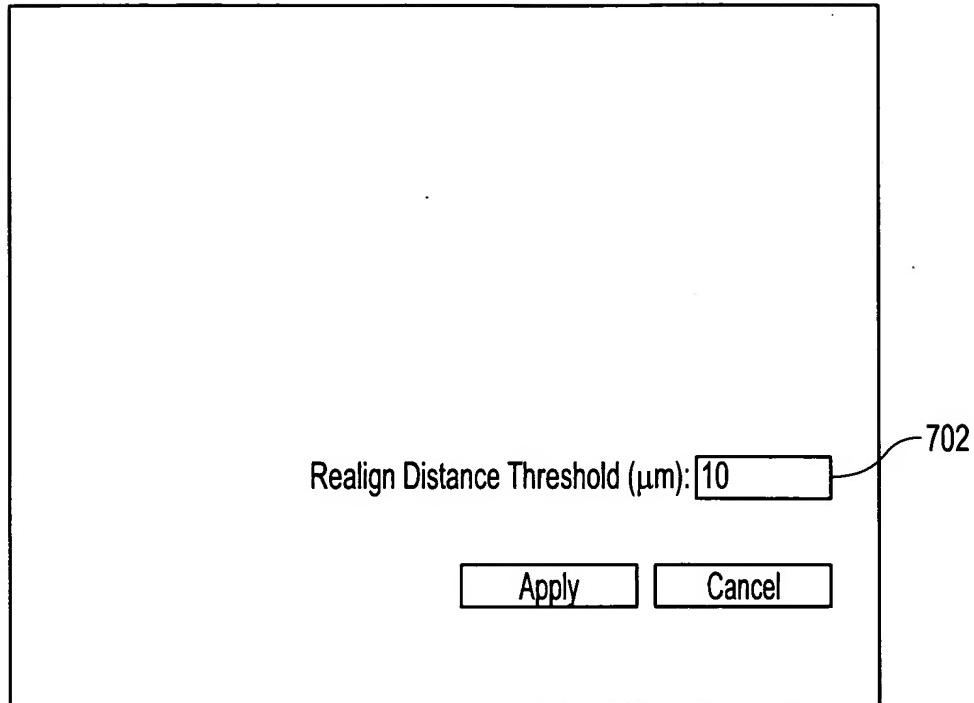


FIG. 6C

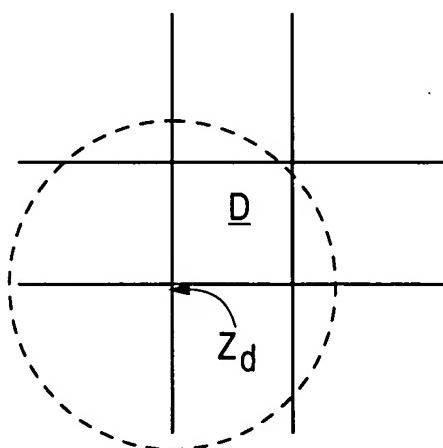


FIG. 7B

<b>Realign</b>		
Beam:	Type:	Assist Timeout:
Ion	Beam Shift	0
<input type="checkbox"/> Display Match Dialog		<input type="checkbox"/> Suppress Errors
<b>Offsets</b>		
<input type="checkbox"/> Field Of View	X: 0.000000	Y: 0.000000
<b>Logging</b>		
<input type="checkbox"/> Enable Logging	Log File: <input type="text"/>	<input type="button" value="..."/>
<input type="button" value="Apply"/> <input type="button" value="Cancel"/>		

FIG. 8A

Item	Description
<b>Realign</b>	
Beam	Specifies the beam to be used in the alignment.
Type	Specifies measurement or the type of alignment. BEAM SHIFT specifies an alignment using beam shift MEASURE instructs the system to measure the X, Y distance between the center of the images and the center of the fiducial mark, in pixels and microns. The result is written to the user-specified log file. STAGE MOVE specifies an alignment using a stage move.
Assist Timeout	Number of seconds a dialog box remains on screen, prompting for user intervention. If this value is 0, no dialog box appears.
Display Match Dialog	Displays the Image Match dialog box (see Image Match).
Suppress Errors	When this option is selected, the system ignores image recognition errors. If ENABLE LOGGING is selected, image recognition errors are written to the user-specified log file.
<b>Offsets:</b>	
Field of View	Specifies a proportional shift of the field of view. When this option is selected, the system shifts the field of view by the proportion of the field of view specified in X and Y. When this option is not selected, the system shifts the field of view by the distance in microns specified in X and Y.
X,Y	Specify the distance by which the system shifts the field of view during alignment. When FIELD OF VIEW is selected, the values specified in X and Y denote a portion of the field of view-e.g., a value of 0.1 equals 10% of the field of view. In one embodiment, acceptable values are 0-1. When FIELD OF VIEW is not selected, the system shifts the field of view by the distance in microns specified in X and Y.
<b>Logging:</b>	
Enable Logging	When this option is selected and a log file is specified, the system logs the following information: Name and path of the image file used for realignment X location of the fiducial in pixels and microns Y location of the fiducial in pixels and microns When MEASURE is selected for TYPE, the X, Y distance between the center of the image and the center of the fiducial mark, in pixels and microns. If the fiducial is not found, the system writes "Fail" to the log file.
Log File	Name and path of the specified log file. Use the adjacent Browse button to navigate to the desired directory.

FIG. 8B

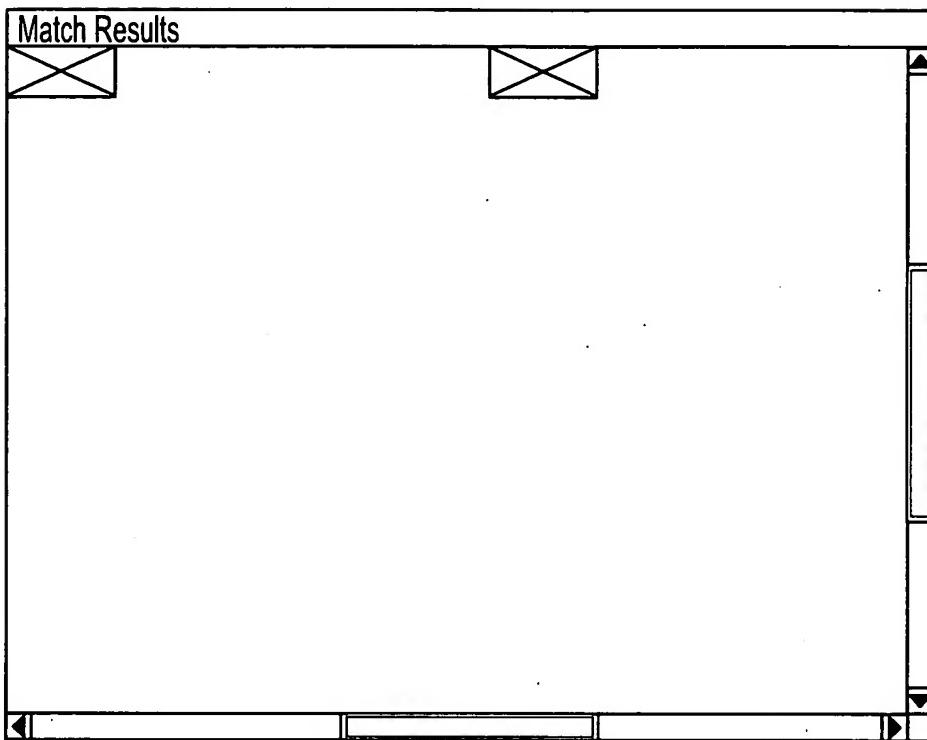


FIG. 8C

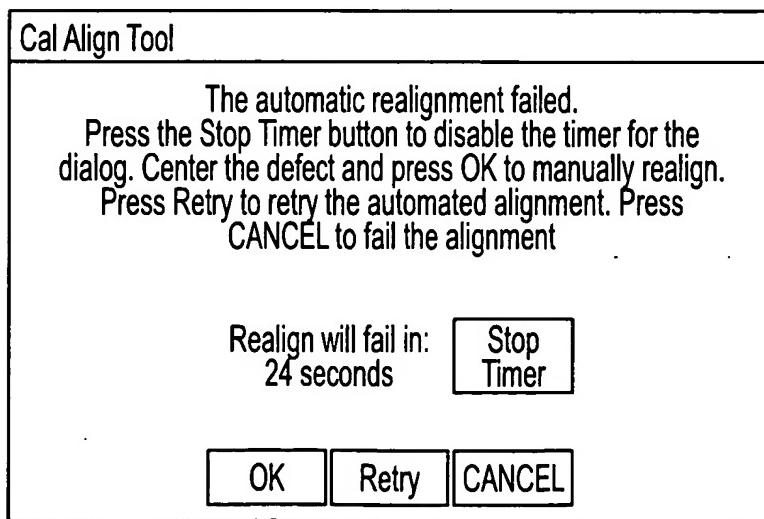


FIG. 8D

**Cross Section Settings**

<b>Deposition</b> Material File <input type="text" value="pt_high.mtr"/> <input type="button" value="▼"/> Width <input type="text" value="10.00"/> % Height <input type="text" value="10.00"/> % Depth <input type="text" value="0.50"/> μm	<b>Bulk Mill</b> Material File <input type="text" value="si.mtr"/> <input type="button" value="▼"/> Width <input type="text" value="10.00"/> % # of Cuts <input type="text" value="10.00"/> Maximum Total Time (Bulk Mill & Cross Section) <input type="text" value="20.00"/> Seconds	<b>Cross Section</b> Material File <input type="text" value="si.mtr"/> <input type="button" value="▼"/> Width <input type="text" value="10.00"/> % Height <input type="text" value="10.00"/> % Depth <input type="text" value="0.50"/> μm
<input type="button" value="Y Offset"/> Current Offset: 0.00 μm		
<input type="button" value="Apply"/> <input type="button" value="Cancel"/>		

*FIG. 9A*

Item	Description
<b>Description</b>	
Material File	Displays a dropdown menu for selecting a material file (.mtr). The list contains an entry for every material file available on the system.
Width	Width of the specified cross section (X), as a percentage of the field of view.
Height	Height of the specified cross section (Y), as a percentage of the field of view. The protective coat will be centered about the location of the cross-section target line.
Depth	Depth of the specified cross section, in microns.
<b>Bulk Mill:</b>	
Number of Cuts	Number of cuts to be made in the bulk mill.
<b>Cross Section:</b>	As in Deposition group, above.
Maximum Total Time	Sets the total pattern time for the bulk mill and cross-section patterning Defect Analyzer uses this value to select the apertures used for bulk milling and cross-sectioning, based on the specified pattern area, depth, and material file.
Y Offset	Displays a horizontal yellow line in the image quadrant, marking the desired upper boundary of the cross section. Click anywhere in the field of view to set the location of this yellow line, then click OK in the accompanying dialog box. For further information, see "Setting Y Offset" on page 4-14.

FIG. 9B

Scan Speed Matrix

	Low	Med	High
Fast	0.028	0.091	0.362
-	0.045	0.181	0.724
-	0.136	0.543	2.173
Slow	0.396	1.584	6.337

Fidicial Tool Configuration

Bitmap:  ...

Size (%FOV) —

Defect:  Fiducial:   
40.000000 10.000000

Integer  1 ▾

Size (%FOV) —

X:  Y:   
30.000000 0.000000

GIS:  Depth:   
None 1.000000

Configure EBeam Realign      Configure IBeam Realign

Config EBeam BMP Realign      Config IBeam BMP Realign

FIG. 10A

Item	Description
Scan speed matrix	Sets the frame time and resolution used in ion beam and electron beam images collected after milling of the fiducial mark. These images are used for subsequent image recognition.
Integrate	Sets the number of frames to be integrated to allow accumulative noise reduction.
Bitmap	Defect Analyzer converts the specified bitmap to a stream file, based on the grayscale levels of individual pixels in the bitmap. Pixels above the median brightness in the grayscale are omitted from the stream file; pixels below the median brightness are converted to points.
Size (%FOV)	
Defect	Proportion of the field of view to be occupied by the defect.
Fiducial	Size of the fiducial mark, as a percentage of the field of view.
Fiducial Offset From Center (%FOV)	Sets the offset between the center of the image and the center of the fiducial mark, in X and Y, as a percentage of the field of view.
GIS	Selects the GIS to be used in milling the fiducial. The List contains an entry for every beam chemistry available on the system.
Depth	Depth of the fiducial mark, in microns.
Configure EBeam Realign	
Configure IBeam Realign	
Configure IBeam BMP Realign, Configure EBeam BMP Realign	CONFIGURE EBEAM BMP REALIGN and CONFIGURE IBEAM BMP REALIGN configure the image recognition software for initial matches between a fiducial mark and the bitmap used as the milling pattern.

FIG. 10B

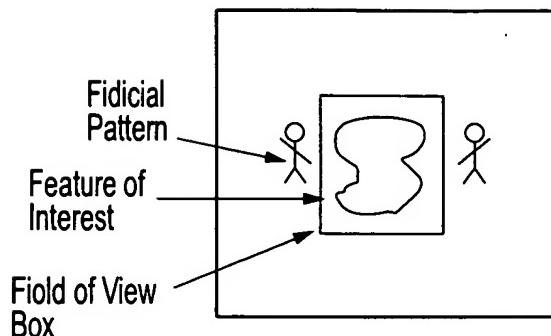


FIG. 10C

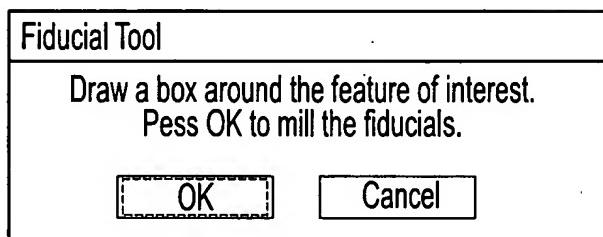


FIG. 10D

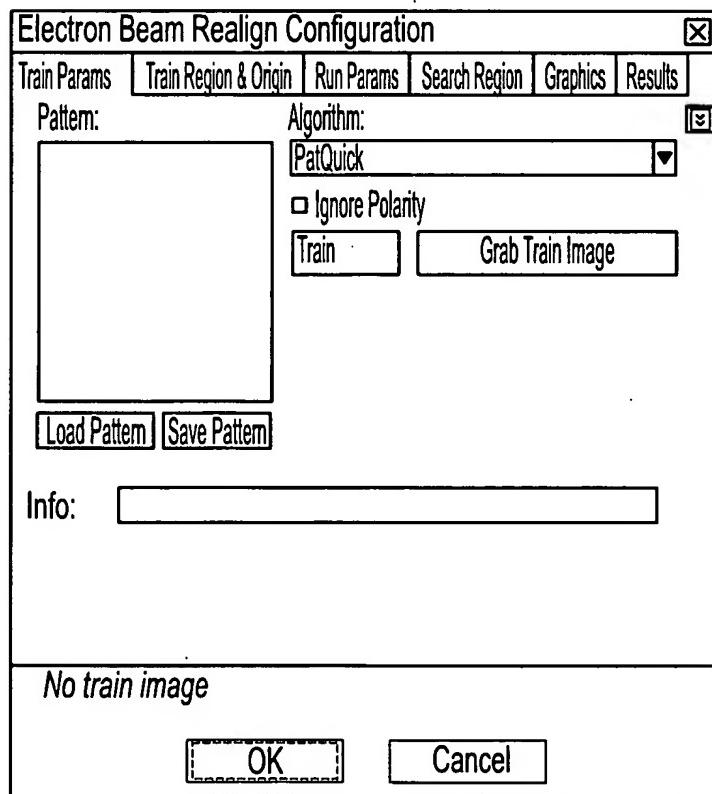


FIG. 10E

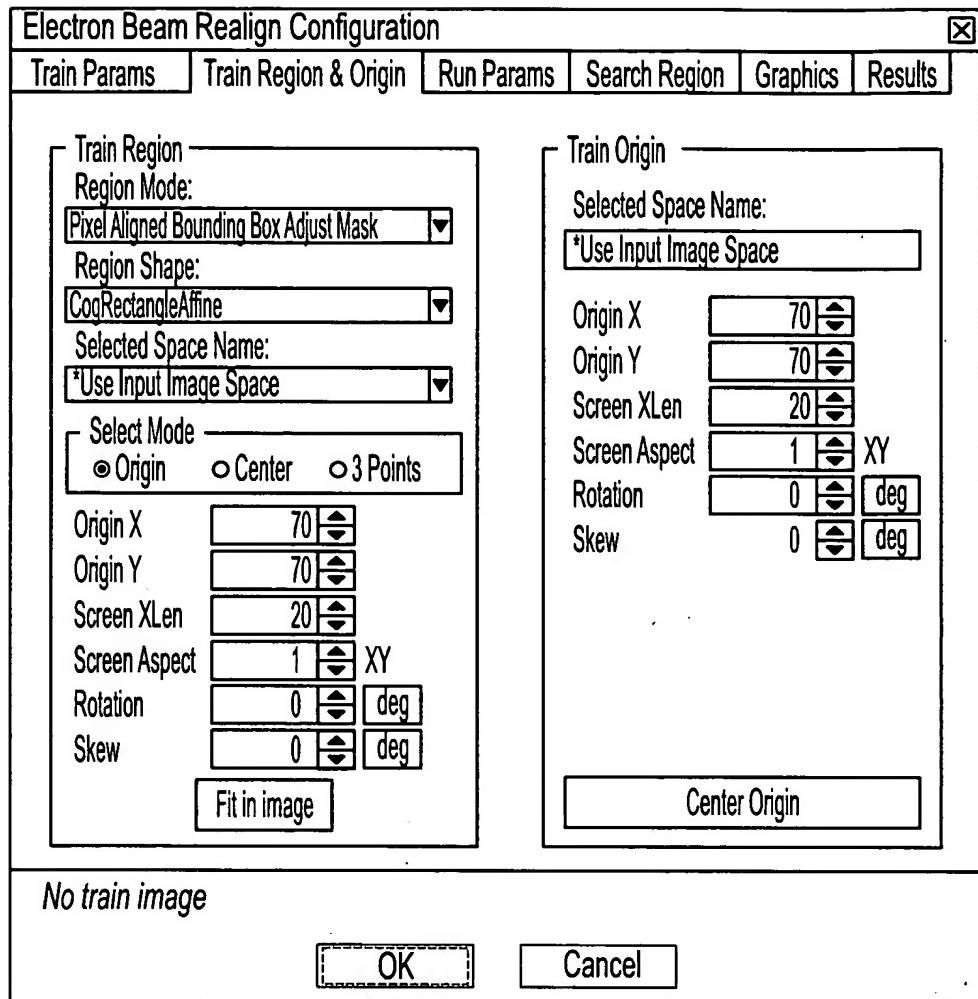


FIG. 10F

**Electron Beam Realign Configuration**

Train Params	Train Region & Origin	Run Params	Search Region	Graphics	Results
--------------	-----------------------	------------	---------------	----------	---------

Algorithm:

Approx no. to find:	1
Accept threshold:	0.5
<input type="checkbox"/> Timeout	50000 ms

Angle	Nominal	Low	High	Overlap
Angle	0 deg	-45 deg	45 deg	360 deg
Scale	1	0.8	1.2	1.4
ScaleX	1 ms	0.0	1.2	1.4
ScaleY	1 ms	0.8	1.2	1.4

Use Pattern Grain Limits

Compare	4	Contrast thresh:	10
fine	1	XY overlap:	0.0

No train image

FIG. 10G

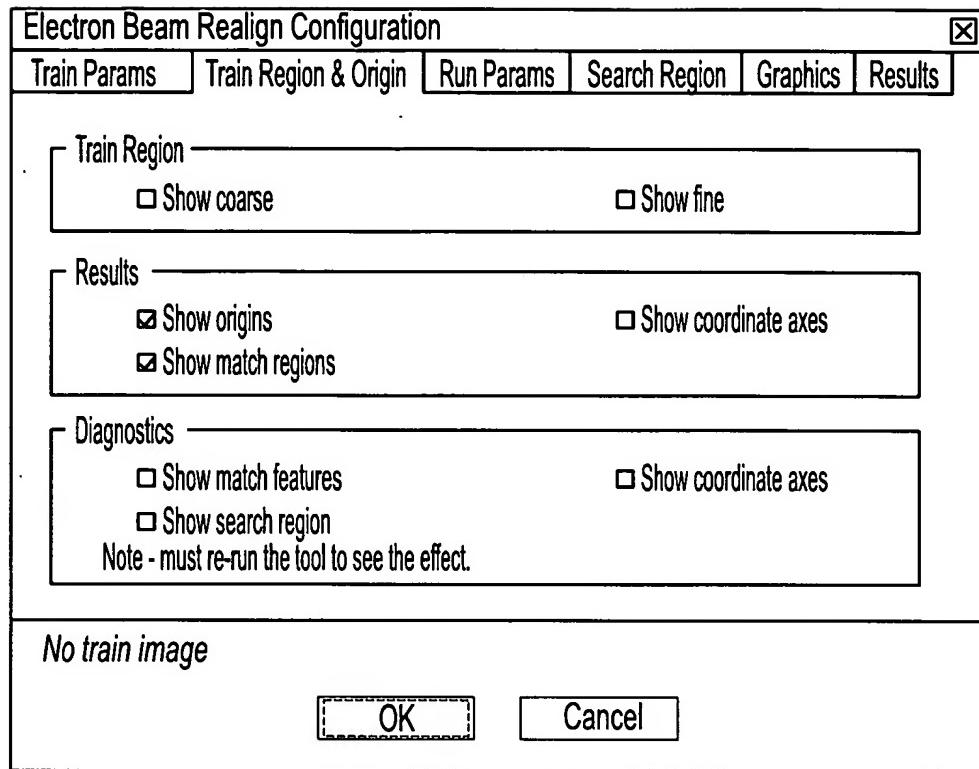


FIG. 10H

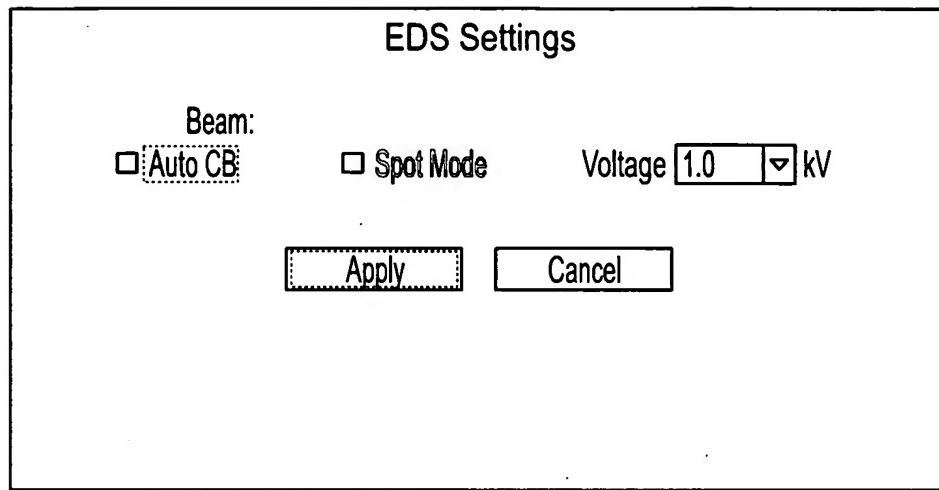
**Cross Section Settings**

Beam:	Realign Using Beam Shift:	
<input type="button" value="Electron"/>	<input type="button" value="Yes"/>	
Enable Logging:	Display Match Dialog	Assist Timeout(s):
	<input type="button" value="No"/>	<input type="button" value="No"/>
X Offset:	Y Offset:	
<input type="button" value="0.000000"/>	<input type="button" value="0.000000"/>	
<input type="button" value="Apply"/> <input type="button" value="Cancel"/>		

*FIG. 11A*

Item	Description
Beam	Specifies the beam to be used in the alignment.
Realign Using Beam Shift	Specifies the type of alignment to be made. YES specifies an alignment made using beam shift. NO specifies an alignment made using a stage move. For best results, realign the electron beam with stage moves and the ion beam with beam shift.
Enable Logging	When this option is selected, the system logs the following information: Name and path of the image file used for realignment X location of the fiducial in pixels and microns Y location of the fiducial in pixels and microns If the fiducial is not found, the system writes "Fail" to the log file.
Display Match Dialog	Displays the Image Match dialogue (see "Image Match" on page 4-10)
Assist Timeout(s)	Number of seconds before a dialog box appears, prompting for user intervention. If this value is 0, no dialog box appears.
FOV Offset	Specifies a proportional shift of the field of view. When this option is selected, the system shifts the field of view by the proportion of the field of view specified in X and Y. When this portion is not selected, the system shifts the field of view by the distance in microns specified in X and Y.
X Offset, Y Offset	Specify the distance by which the system shifts the field of view during alignment. When FIELD OF VIEW is selected, the values specified in X and Y denote a portion of the field of view-e.g., a value of 0.1 equals 10% of the field of view. Acceptable values are 0-1. When FIELD OF VIEW is not selected, the system shifts the field of view by the distance in microns specified in X and Y.

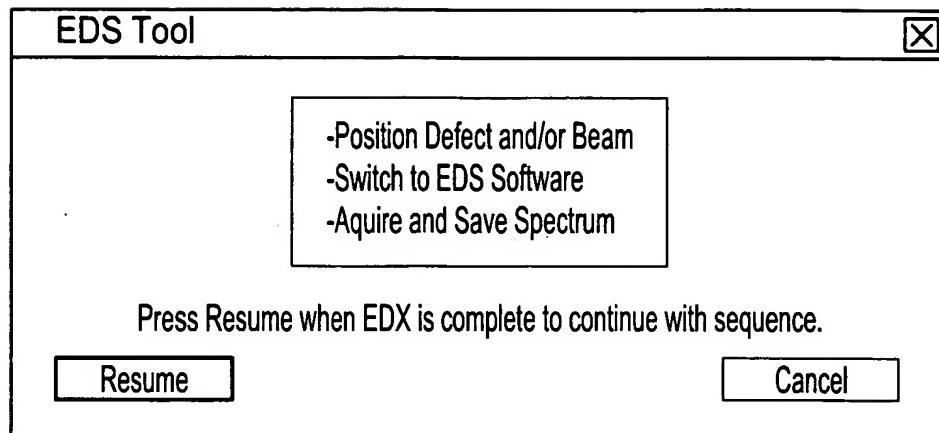
*FIG. 11B*



*FIG. 12A*

Item	Description
Auto CB	Performs automatic contrast and brightness
Spot Mode	Selects Spot as the scanning mode.
Voltage	Voltage to be used to acquire spectrum.

*FIG. 12B*



*FIG. 12C*

Interface items	Description
Resume	Associates the spectrum with the current site and continues automated processing.
Voltage	Does not put anything into the database and gives you the option to fail the site.

*FIG. 12D*

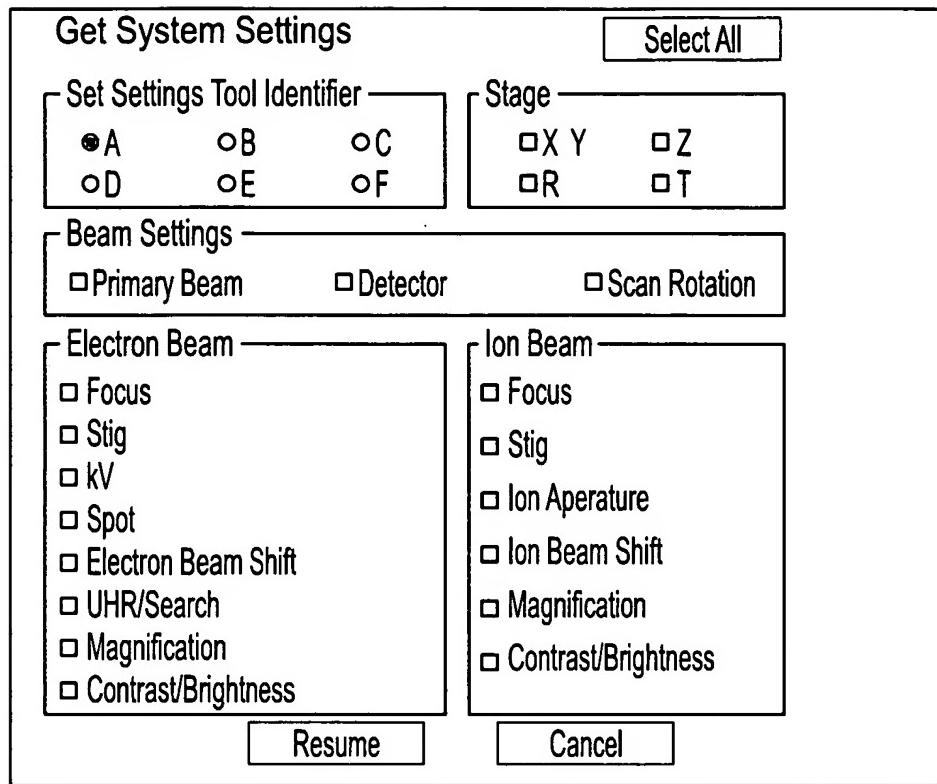


FIG. 13A

Item	Description
Select All/De-Select All	Selects or deselects every option in the Stage, Beam Settings, Electron Beam, and Ion Beam groups.
Set Settings Tool Identifier	Identifies a set of stored settings
Stage	Contains options for recording the positions of the five independent axes.
Beam Settings	Contains options for recording the following current beam settings.
Primary Beam	
Detector	
Scan Rotation	
Electron Beam	Contains options for recording the current electron beam parameters. Focus, Stigmation, Accelerating voltage (kV), Spot size, Beam shift, Mode (UHR or Search), Magnification, Contrast/Brightness
Ion Beam	Contains options for recording the current electron beam parameters. Focus, Stigmation, Apperatus, Beam shift, Magnification, Contrast/Brightness

FIG. 13B

**Grab Image Settings**

E-Beam     I-Beam

Detector	Voltage (kV) <input type="text" value="1.0"/>	Spot Size <input type="text" value="1.0"/>	Ion Settings	Aperature <input type="text" value="10"/>
Detector	<input checked="" type="radio"/> TLD-S <input type="radio"/> TLD-B <input type="radio"/> TLD-C <input type="radio"/> TLD-D <input type="radio"/> CDM-E <input type="radio"/> CEM-I	Mode	<input checked="" type="radio"/> UHR <input type="radio"/> Search	Resolution
		Integrate	<input type="text" value="1"/>	Low    Med    High
				Fast <input type="text" value="0.028"/> <input type="text" value="0.091"/> <input type="text" value="0.362"/>
				- <input type="text" value="0.045"/> <input type="text" value="0.181"/> <input type="text" value="0.724"/>
				- <input type="text" value="0.136"/> <input type="text" value="0.543"/> <input type="text" value="2.173"/>
				Slow <input type="text" value="0.396"/> <input type="text" value="1.584"/> <input type="text" value="6.337"/>
Magnification	<input type="radio"/> FOV <input checked="" type="radio"/> Fixed <input type="text" value="2500X"/>	Integer	<input type="text" value="1"/>	Apply    Cancel

FIG. 13C

Item	Description
E-Beam	Use electron beam to grab an image.
I-Beam	Use ion beam to grab an image.
Electron Settings:	
Voltage (kV)	Active only for the electron beam. Specify the accelerating voltage.
Spot Size	Active only for the electron beam. Specify the spot size.
Detector	Select the detector used to collect the image. Available selections are dependent on the selected mode and beam. Refer to the xP DualBeam Workstation User's Guide (PN 25417) for information about detector types.
Mode	Active only for the electron beam. Select Search mode for low magnifications and UHR mode for higher magnifications.
Image:	
ACB	Automatically adjusts contrast and brightness using the stored values for comparison.
AutoFocus	Automatically corrects the focus, based on the system sharpness criteria.
AutoStig	Automatically corrects sigmatism, based on the system sharpness criteria. Available for the electron beam.
Data Bar	Save the databar as seen into the image.
Magnification	Specifies the magnification used to grab the image. Select either the field-of-view(determined by the Fiducial tool) or choose from a range of preset magnifications.
Ion Aperture	Active only for the ion beam. Sets the ion aperture.
Resolution	Selects the scan rate and resolution for grabbing a single frame. The values are those available for Grab Image.
Integrate	Specifies the number of collected images to be summed to generate the final image.

FIG. 13D

**Pattern Settings**

Use FOV%

Dimensions

X:	0.00	μm
Y:	0.00	μm
Z:	0.00	μm

Center Position

X:	0.00	μm
Y:	0.00	μm

Overlap  %

Dwell  μs

Time  μs

Always Realign

Primary Beam

I-Beam  E-Beam

Material File

Material File

Rotation  Degrees

**Show Pattern**      **Apply**

FIG. 14A

Item	Description
Use FOV%	Converts X and Y coordinates in Dimensions and Center Position to a percentage of the field of view When this option is selected X and Y coordinates in Dimensions and Center Position denote a percentage of the field of view. When this option is not selected, X and Y coordinates in Dimensions and Center Position are in microns.
Dimensions	Sets the X, Y, and Z pattern dimensions. When Pattern Type is set to Circle, X and Y are replaced by Rin (inner radius) and Rout (outer radius)
Center Position	Shows the stage X and Y coordinates of the center of the pattern relative to the center of the field of view.
Overlap	Beam overlap. Not available when a material file is selected.
Dwell	Dwell time per pixel. Not available when a material file is selected.
Time	Time for milling displayed as either hh:mm:ss or ss:ttt.
Always Realign	When this portion is selected, the system always realigns to the fiducial mark before milling the specified pattern. When this option is selected, the system only realigns to the fiducial mark when an aperture has changed or a GIS needle has been inserted.
Show Pattern/Remove Pattern	Displays the currently defined pattern. When a pattern is already on screen, removes that pattern
Primary Beam	Select I-Beam or E-BEAM as the beam that will be used for patterning
Material File	Select the material file for your application. Refer to the xP DualBeam Workstation User's Guide (PN 25417) for information about material files.
Pattern Type	Defines the pattern. Refer to the xP DualBeam Workstation User's Guide (PN 25417) for information about available patterns.
Rotation	Rotates the pattern about its center to the specified angle.

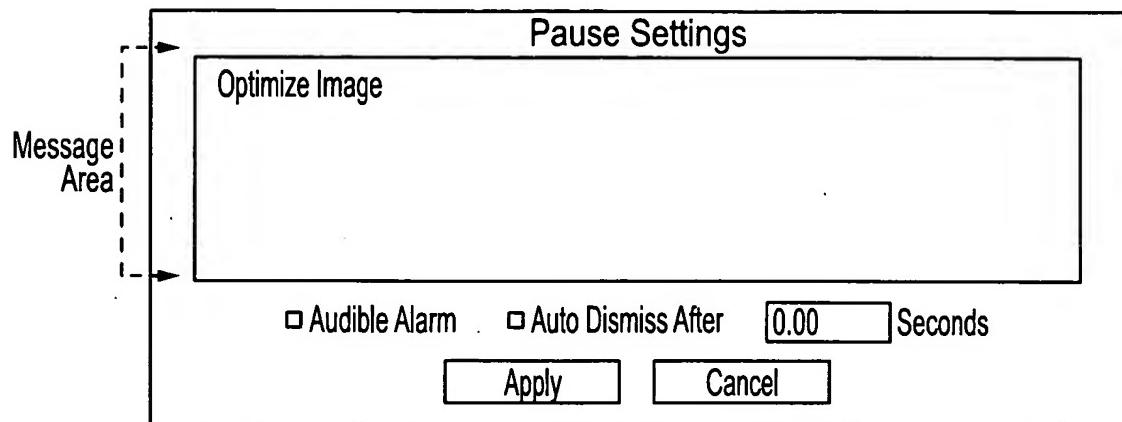


FIG. 15A

Item	Description
Message area	Defines actions the user should take before continuing processing.
Audible alarm	Cause an alarm to sound when the Pause dialog box displays during a job.
Auto dismiss	Selects if the Pause dialog box should time out. Otherwise, the Pause dialog box must be manually dismissed.
	The number of seconds specifies the fixed amount of time Pause dialog box is displayed during a job.

FIG. 15B

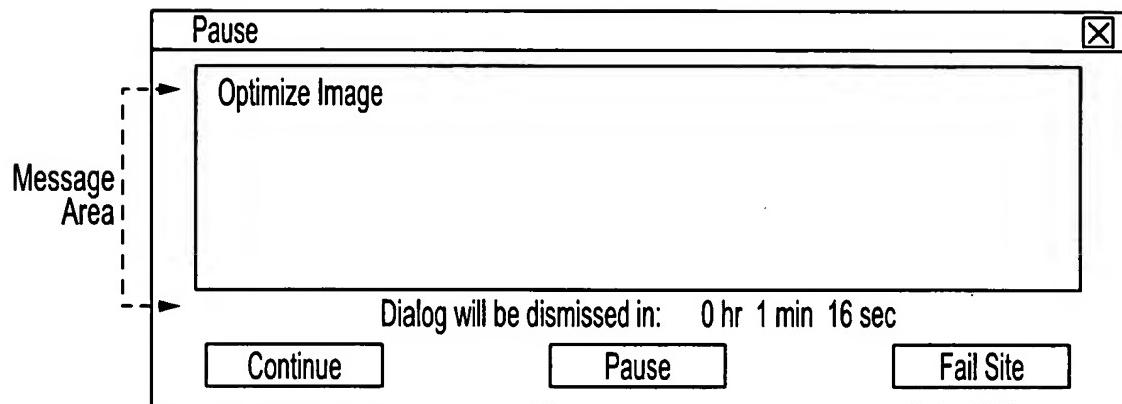


FIG. 15C

Item	Description
Message area	Defines action operator should take before proceeding with the process. The text cannot be modified during runtime.
Timeout clock	The time the dialog box will be displayed during a job. If the operator does not interact with the tool, the Pause dialog box times out as specified and the process automatically continues.
Continue	Click to continue processing the current site. The site list grid will show that the site passed.
Pause/Resume	Stop/restarts the timer. (This button is inactive if AUTO DISMISS was not selected during configuration.) The process waits for the operator to click either CONTINUE or FAIL.
Fail Site	Click to fail the current site. Further processing at the site is aborted. Processing starts at the next site. The site list grid will show that the site failed. If the entire job is to be aborted, the operator can click ABORT in the Run Tool Sequence dialog box

FIG. 15D

**Get System Settings**

Get Settings Identifier

<input checked="" type="radio"/> A	<input type="radio"/> B	<input type="radio"/> C
<input type="radio"/> D	<input type="radio"/> E	<input type="radio"/> F

**Resume**      **Cancel**

FIG. 16

**Slice and View Settings**

**Slice**

<input type="radio"/> Size of Slices <input type="text" value="107.9"/> μm	<input type="checkbox"/> Limit max# of slices to <input type="text" value="50"/>
<input type="radio"/> Number of Slices <input type="text" value="1"/>	<input type="checkbox"/> Hair Cut
Depth <input type="text" value="0.50"/> μm	<input type="checkbox"/> Material File <input type="text" value="None"/>
Max Process Time <input type="text" value="120.0"/> sec	

**Metal Deposition**

<input type="checkbox"/> Add Protective Coating
Material File <input type="text" value="None"/>
Pattern Width <input type="text" value="0.50"/> % of Defect
Pattern Height <input type="text" value="0.50"/> μm

**Image**

	Low	Med	High
Fast	0.028	0.091	0.362
-	0.045	0.181	0.724
-	0.136	0.543	2.173
Slow	0.396	1.584	6.337

Integrate

Data Bar       Track Image

ACB       Auto Focus

Field of View:  % of X-section

**Electron HV and Spot Size**

<input type="text" value="1.0"/> kV	<input type="text" value="1"/> Spot
-------------------------------------	-------------------------------------

**Mode**

<input type="radio"/> UHR
<input checked="" type="radio"/> Search

**Detector**

<input checked="" type="radio"/> TLD-S	<input type="radio"/> TLD-D
<input type="radio"/> TLD-B	<input type="radio"/> CDM-E
<input type="radio"/> TLD-C	<input type="radio"/> CEM-I

**Apply**      **Cancel**

FIG. 17A

Item	Description
Slice:	User selects either SIZE OF SLICES or NUMBER OF SLICES.
Size of Slices	Specifies the slice size in microns. The number of slices to be milled will be calculated by dividing the size of the defect (determined by fiducial tool) by the size of the slices.
Limit max # of slices to	The Maximum number of slices to be made in the Slice and View area.
Number of Slices	Specifies the number of slices to be milled. The height of each slice is determined by the software dividing the value specified for height (y) by the number of slices. Where is height from? A maximum of 100 individual patterns can be displayed. If the tool calls for more than 100 slices, an outline indicating the overall area to be sliced is displayed.
Depth	Specifies the pattern depth in microns.
Half Cut	Mills only half way through the defect selected (up to the center cross).
Material File	Displays a dropdown list of selecting a material file (.mtr). The list contains an entry for every material file available on the system. The default material file is si.mtr.
Max Process Time	The Maximum time process may occur
Metal Deposition:	
Add Protective Coating	If this option is selected, a protective layer will be centered about the Slice and View area. The scale will be set in the job builder configuration and based upon the size of the slice and view area. If protective coating is not selected, the fields associated with it should be inactive.
Material File	Displays a dropdown list for selecting a material file (.mtr). The list contains an entry for every material file available on the system. the default material file is either pt_high mtr.
Pattern Width	Specifies the pattern width, as a percentage of the defect size.
Pattern Height	Specifies the pattern height, in microns.
Image:	
Scan Speed Matrix	Sets the frame time and resolution used for the electron beam images of the cross-section face. These values correspond generally to the faster continuous scan rates available in xP. Refer to the xP DualBeam Workstation User's Guide for information about the available resolutions.
Integrate	Number of frames to integrate for accumulative noise reductions.
Data Bar	Includes the databar configured in xP in the image.
ACB	Selects automatically adjusting contrast and brightness, using the stored values for comparison.
Track Image	Adjusts the electron beam shaft to keep the face of the cross section centered in the field of view.
Auto Focus	Initiates automated focus before the system begins capturing electron beam images.
Field of View	Specifies the field of view used for electron beam images of the cross-section face, as a percentage of the cross-section.
Electron HV and Spotsizes:	kV specifies the electron beam accelerating voltage, Select from the range of voltages available for the currently selected imaging mode. SPOTSIZE specifies the actual focused area of the electron beam on the sample.
Mode	Select UHR or Search as the imaging mode..
Detector	Select the detector to be used for the electron beam images. Choices are determined by the currently selected imaging mode.

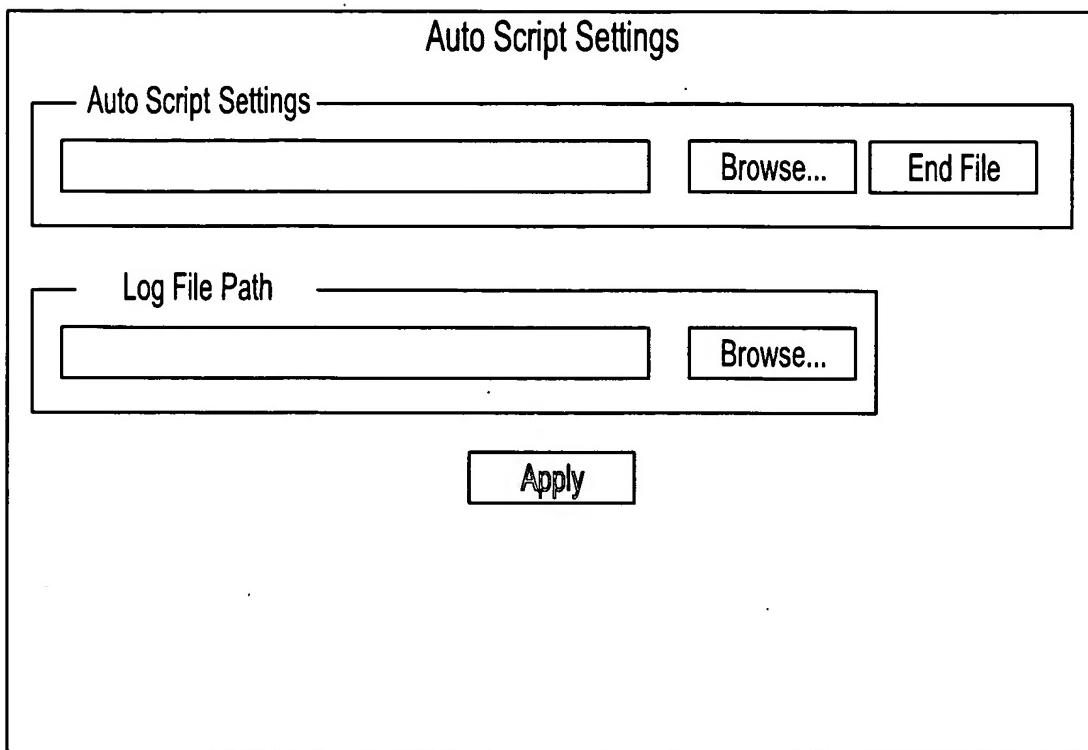


FIG. 18A

Item	Description
Script File Path	Name and path of the AutoScript file.
Browser	Accesses the Open dialog box so you can navigate to a script file.
Edit File	Opens the selected script file in the Windows Notepad text editor.
Log File Path	Name and path of the log file.
Browse	Accesses the Open dialog box so you can navigate to the log file.

FIG. 18B

**System Settings**

**Get Current System Settings**

<b>Stage</b> <input type="radio"/> Absolute <input checked="" type="radio"/> Relative  <input type="checkbox"/> X <input type="text" value="0.00"/> <input type="checkbox"/> Y <input type="text" value="0.00"/> <input type="checkbox"/> Z <input type="text" value="0.00"/> <input type="checkbox"/> R <input type="text" value="0.00"/> <input type="checkbox"/> T <input type="text" value="0.00"/>	<b>Beam</b> <input type="checkbox"/> Primary Beam <input checked="" type="radio"/> Electron <input type="radio"/> Ion  <input type="checkbox"/> Magnification <input type="text" value="10000.00"/> <input type="checkbox"/> Scan Rotation <input type="text" value="0.00"/>	<b>Electron Beam</b> <input type="checkbox"/> kV <input type="text" value="2.0"/> <input type="checkbox"/> FWD <input type="text" value="5.00"/> <input type="checkbox"/> Spot <input type="text" value="3"/> <input type="checkbox"/> Mode <input type="radio"/> UHR <input checked="" type="radio"/> Search  <b>Ion Beam</b> <input type="checkbox"/> Ion Aperture <input type="text" value="30"/>
<input type="button" value="Apply"/> <input type="button" value="Cancel"/>		

*FIG. 19A*

Item	Description
Get Current System Setting	Gets the current system settings for all options.
<b>Stage:</b>	
Absolute	Chooses coordinates measured from the center of the stage.
Relative	Chooses coordinates measured from the current location on the stage
X,Y,Z,R,T	Sets the positions of the five independent axes.
<b>Beam:</b>	
Primary Beam	Sets the icon beam or electron beam as the primary beam. The selected beam sets the magnification and other image data of the current image window.
Magnification	Sets magnification to the specified value.
Scan Rotation	Sets scan rotation to the specified value.
<b>Electron Beam:</b>	Sets scan rotation to the specified value.
kV	Sets the accelerating voltage for the electron beam. Choose a value from the adjacent dropdown list.
FWD	Sets the electron beam focus to the free working distance specified in the adjacent edit box.
Spot	Sets the aperture size for the electron beam. Choose a value from the adjacent dropdown box.
Mode	Selects the mode for the electron beam.
<b>Ion Beam:</b>	
Ion Aperture	Sets the ion beam current to the aperture (inpA) specified in the adjacent dropdown list.

*FIG. 19B*

<b>ADR Parameters</b>		<b>DThresh Display:</b>	
Die Offset (x-axis)	5000	12	3
<input type="checkbox"/> Center Defect	%FOV	Text2	
<input type="checkbox"/> Probe Eucentric for Reference Image?		Noise Filter: Full	
<input type="checkbox"/> use system state		<b>Electron HV and Spot Size</b>	
<input checked="" type="radio"/> E-Beam <input type="radio"/> I-Beam		1kV	3
<b>Magnification</b>		<b>Ion Aperture</b>	
<input type="radio"/> FOV		3	
<input checked="" type="radio"/> Fixed	2500X		
<b>Detector</b>		<b>Mode</b>	
<input checked="" type="radio"/> TLD-S		<input checked="" type="radio"/> UHR	
<input type="radio"/> TLD-B		<input type="radio"/> Search	
<input type="radio"/> TLD-C		<b>Integrate</b>	
<input type="radio"/> TLD-D		1	
<input type="radio"/> CDM-E		<b>Resolution</b>	
<input type="radio"/> CEM-I		Med-5.66	
		<input checked="" type="checkbox"/> Save Data Bar On Image	
		<input type="checkbox"/> ACB	
		<input type="checkbox"/> AutoFocus	
		<input type="checkbox"/> AutoStig	

FIG. 20A

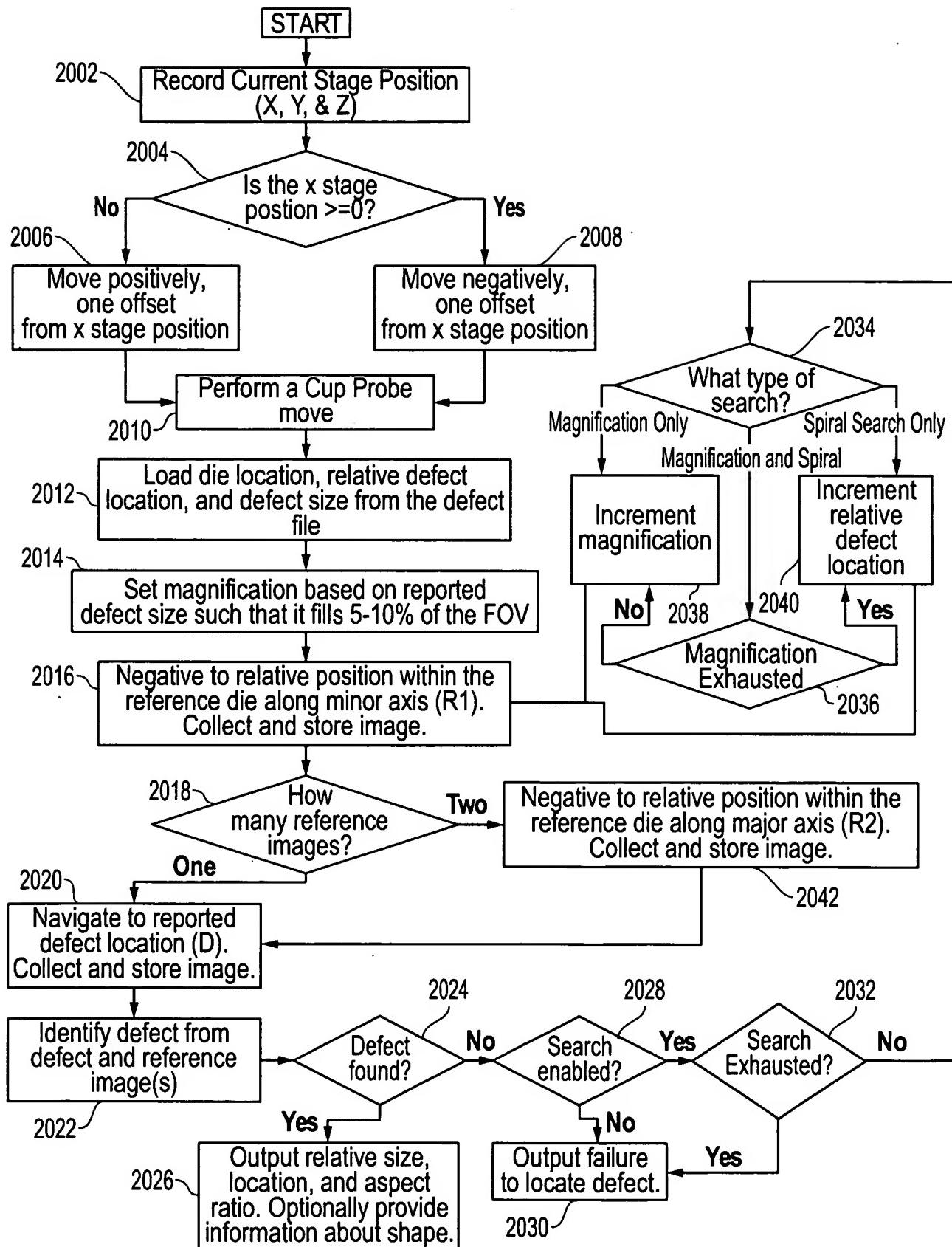


FIG. 20B

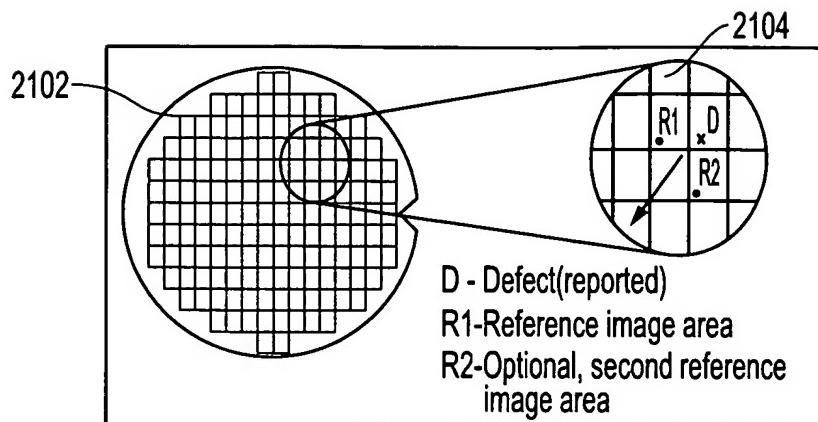


FIG. 21

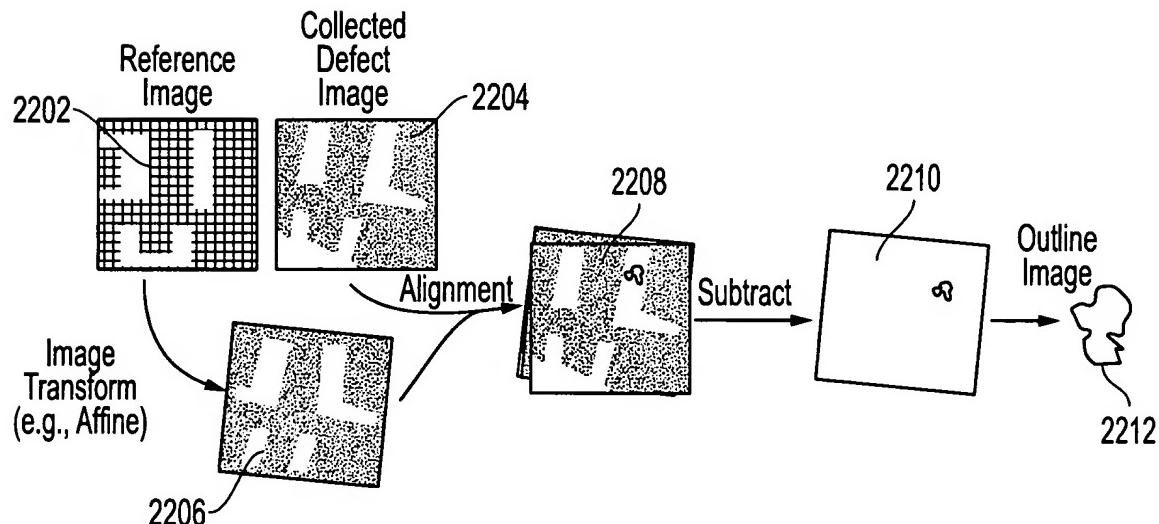


FIG. 22

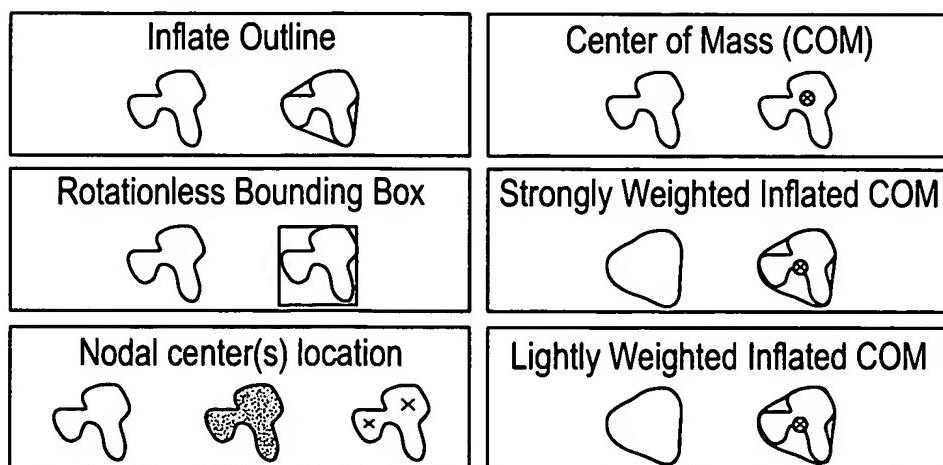


FIG. 23A

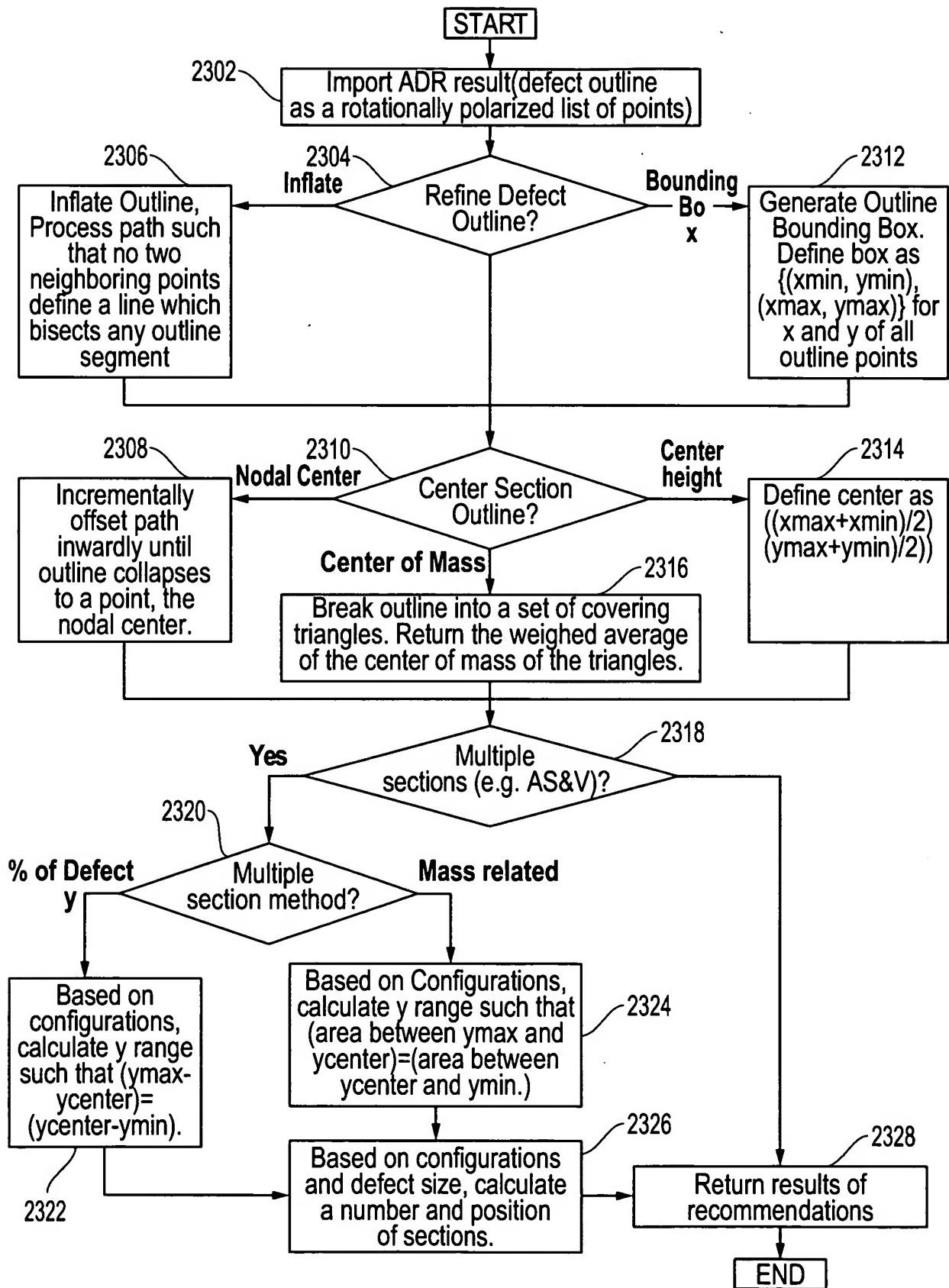


FIG. 23B

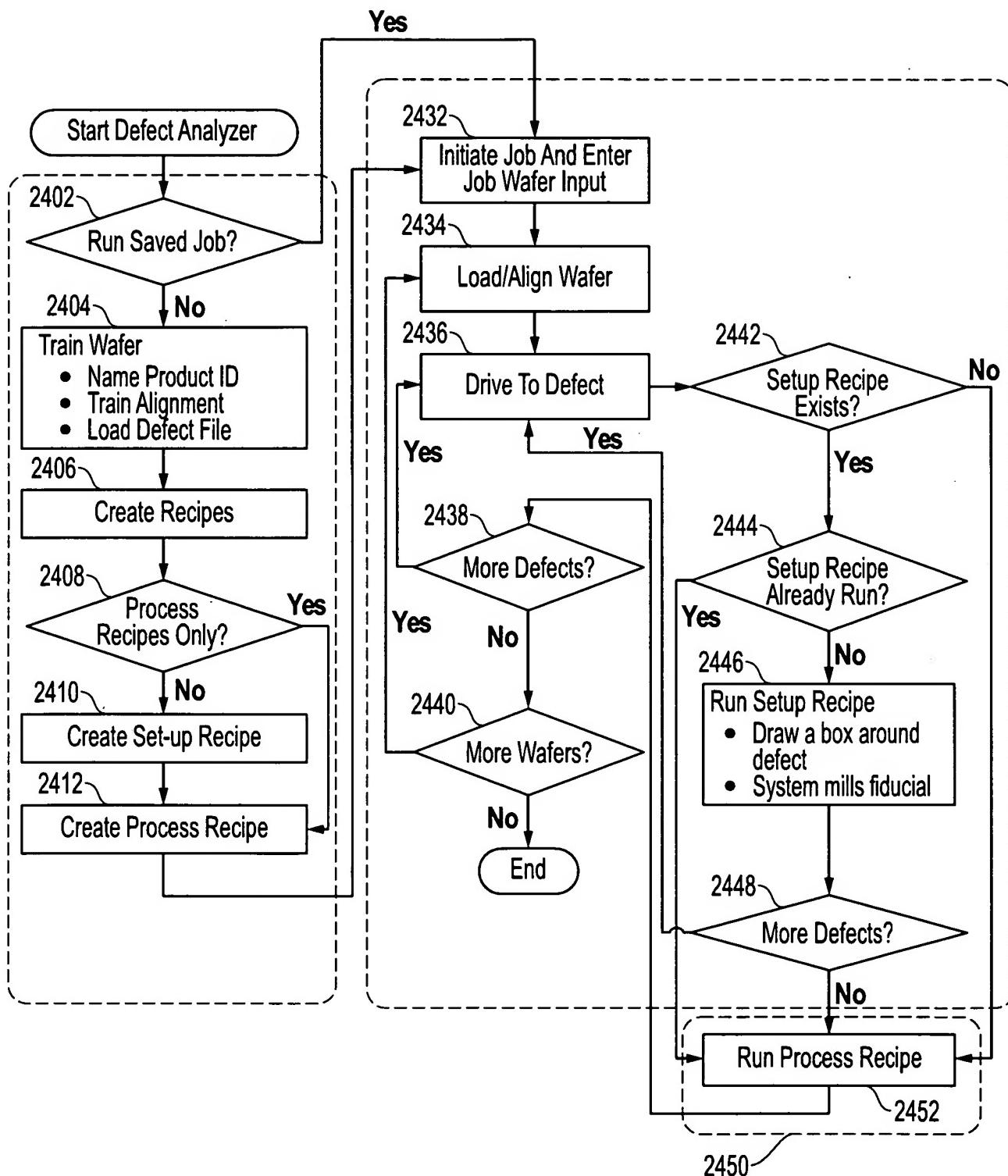


FIG. 24

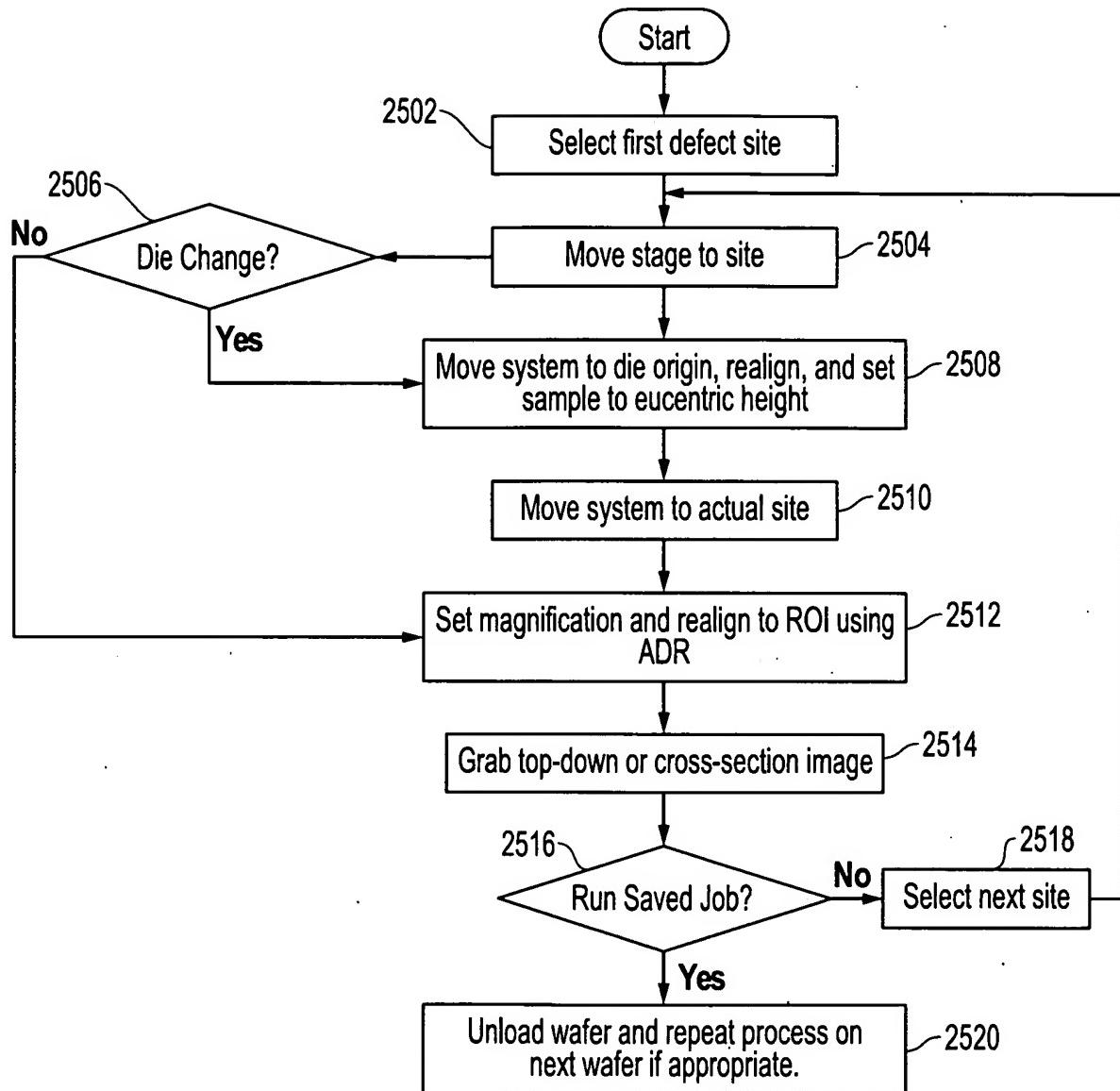


FIG. 25

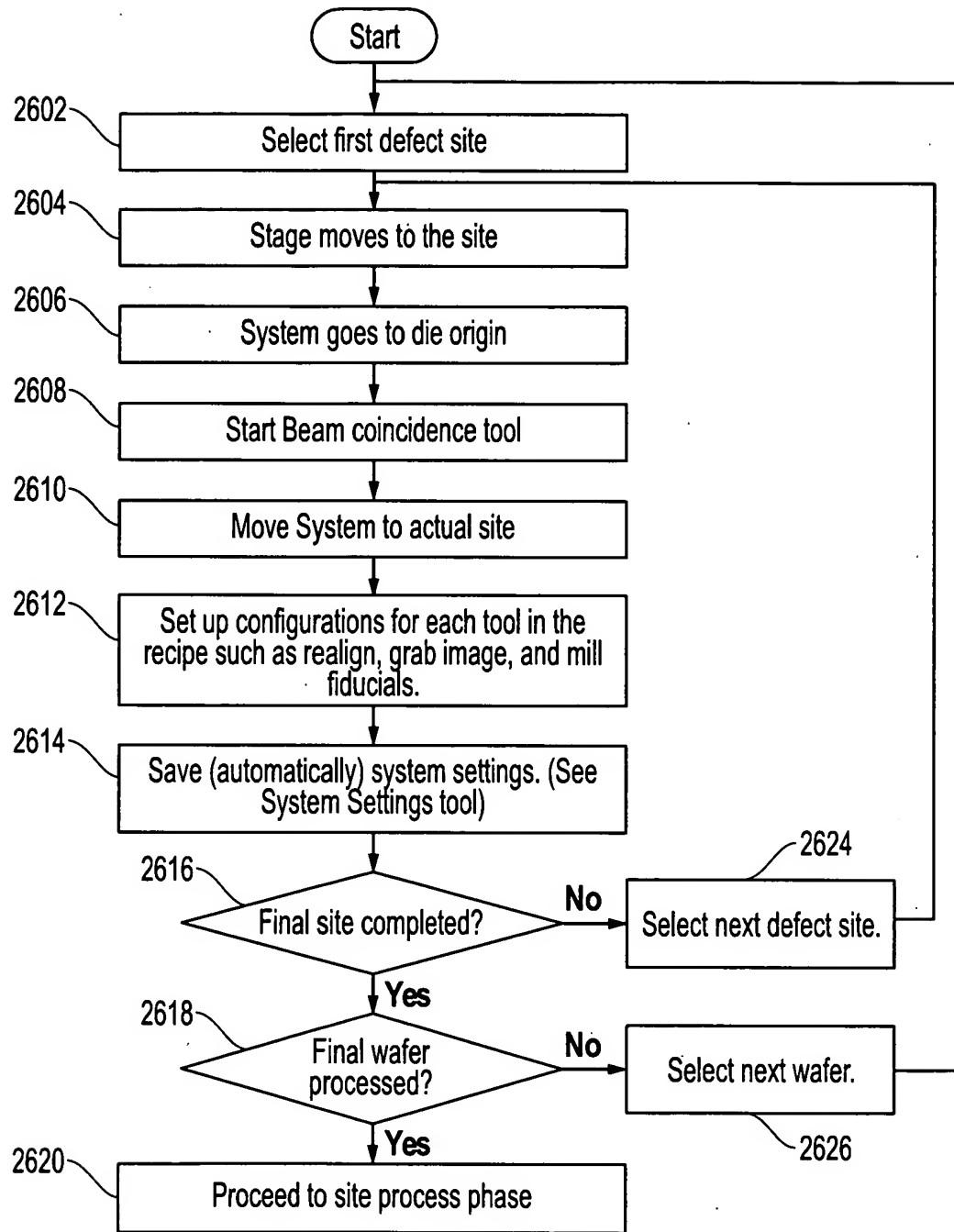


FIG. 26A

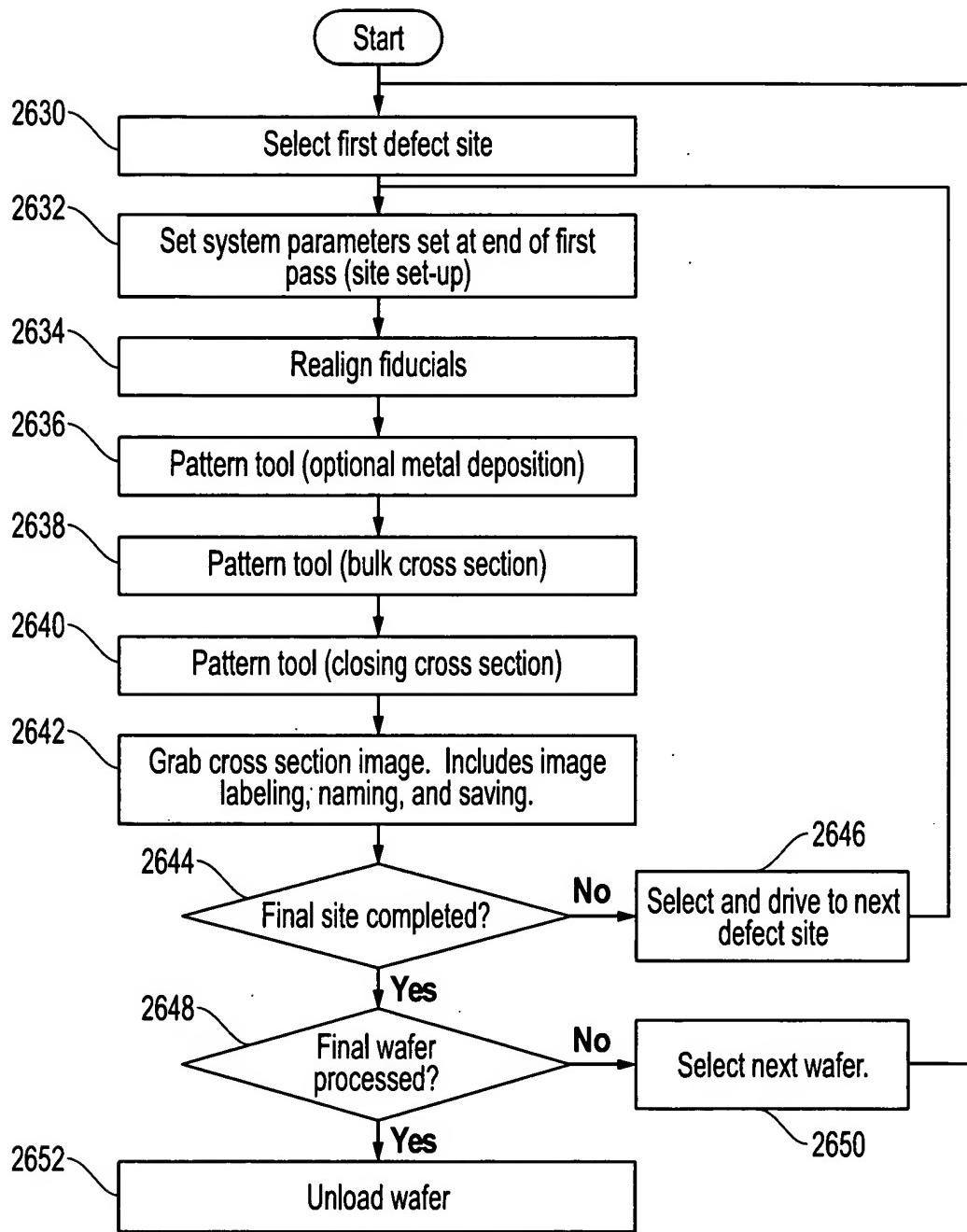


FIG. 26B

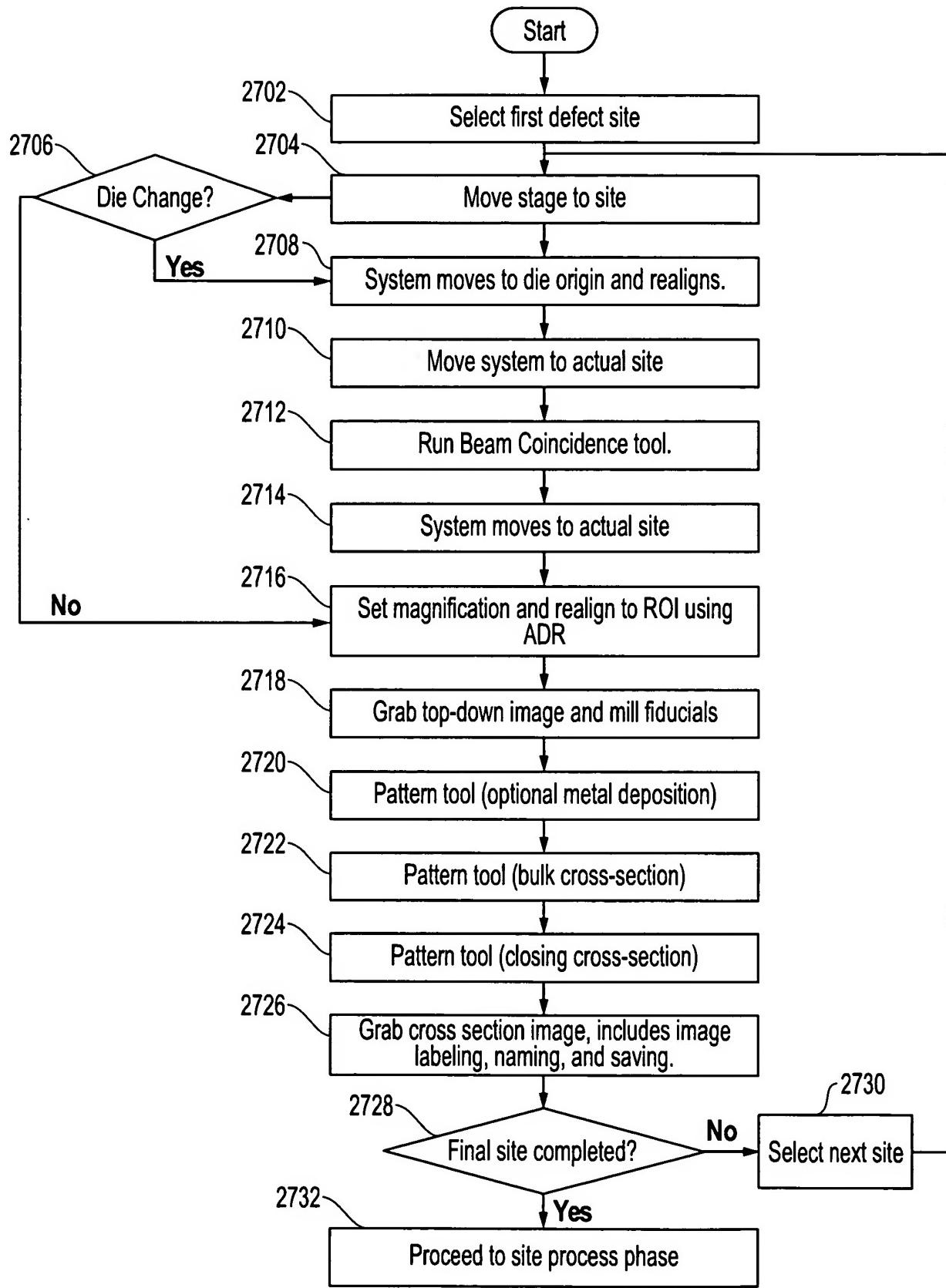


FIG. 27